

## 1A LDO Voltage Regulator with "GreenOperation"

☆GreenOperation-Compatible

### ■GENERAL DESCRIPTION

The XC6220 series is a highly accurate, low noise, high speed, low dropout, and large current CMOS voltage regulator with GreenOperation function. The series consists of a voltage reference, an error amplifier, a current limiter, an inrush current prevention circuit and a phase compensation circuit plus a driver transistor.

With a 0.2Ω on-resistance driver transistor integrated and with output currents up to 1A, the ultra low dropout voltage performance greatly extends battery life as does the GreenOperation function which can switch between high speed and power save modes automatically. Low ESR ceramic capacitors can be used for the output stabilization capacitor ( $C_L$ ).

Output voltage is selectable in 0.05V increments within the range of 0.8V~5.0V, using laser trimming technologies.

An over current protection circuit and a thermal shutdown circuit are built in. The over current protection circuit will operate when the output current reaches its limit current. The thermal shutdown circuit will operate when the junction temperature reaches its limit temperature. The inrush protection circuit works by controlling the inrush current which is charged to  $C_L$  when the IC starts up. In this way, any fluctuations to  $V_{IN}$  caused by inrush current during system start up can be minimized.

The CE function enables the output to be turned off and the IC becomes a stand-by mode resulting in greatly reduced power consumption.

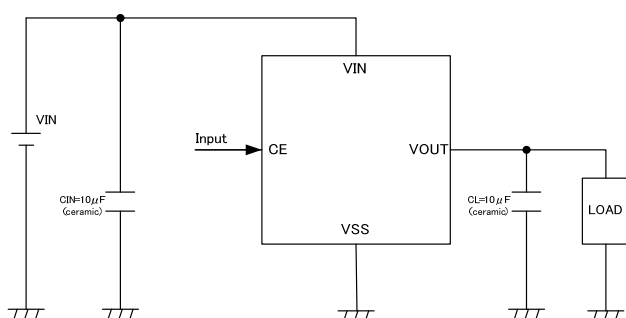
### ■APPLICATIONS

- CD-ROM, CD-R/RW drives
- DVD drives
- HDD drives
- MIDs, UMPCs
- Digital still cameras, Video cameras
- Portable AV equipment

### ■FEATURES

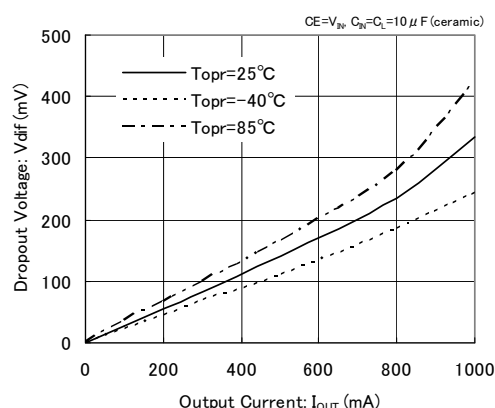
<b>Maximum Output Current</b>	: 1000mA (TYP.:1200mA limit) ( $1.2V \leq V_{OUT} \leq 5.0V$ )
<b>Dropout Voltage</b>	: 20mV @ 100mA ( $V_{OUT}=3.0V$ ) : 60mV @ 300mA ( $V_{OUT}=3.0V$ )
<b>Operating Voltage Range</b>	: 1.6V ~ 6.0V
<b>Output Voltage Range</b>	: 0.8V ~ 5.0V (0.05V increments)
<b>Accuracy</b>	: $\pm 1\%$ ( $V_{OUT} \geq 2.0V$ ) : $\pm 20mV$ ( $V_{OUT} < 2.0V$ )
<b>Low Power Consumption</b>	: $8 \mu A$ (TYP.) in PS mode : $50 \mu A$ (TYP.) in HS mode
<b>Operating Temperature</b>	: -40°C ~ +85°C
<b>Thermal Shutdown</b>	: Detect 150°C, Release 135°C(TYP.)
<b>Inrush Current Protection</b>	: 700mA (MAX.)
<b><math>C_L</math> Auto Discharge</b>	: XC6220B/D Series
<b>CE Pull-Down Resistor</b>	: XC6220C/D Series
<b>Output Capacitor</b>	: Ceramic Capacitor Compatible
<b>Packages</b>	: USP-6C, SOT-25, SOT-89-5
<b>Environmentally Friendly</b>	: EU RoHS Compliant, Pb Free

### ■TYPICAL APPLICATION CIRCUIT

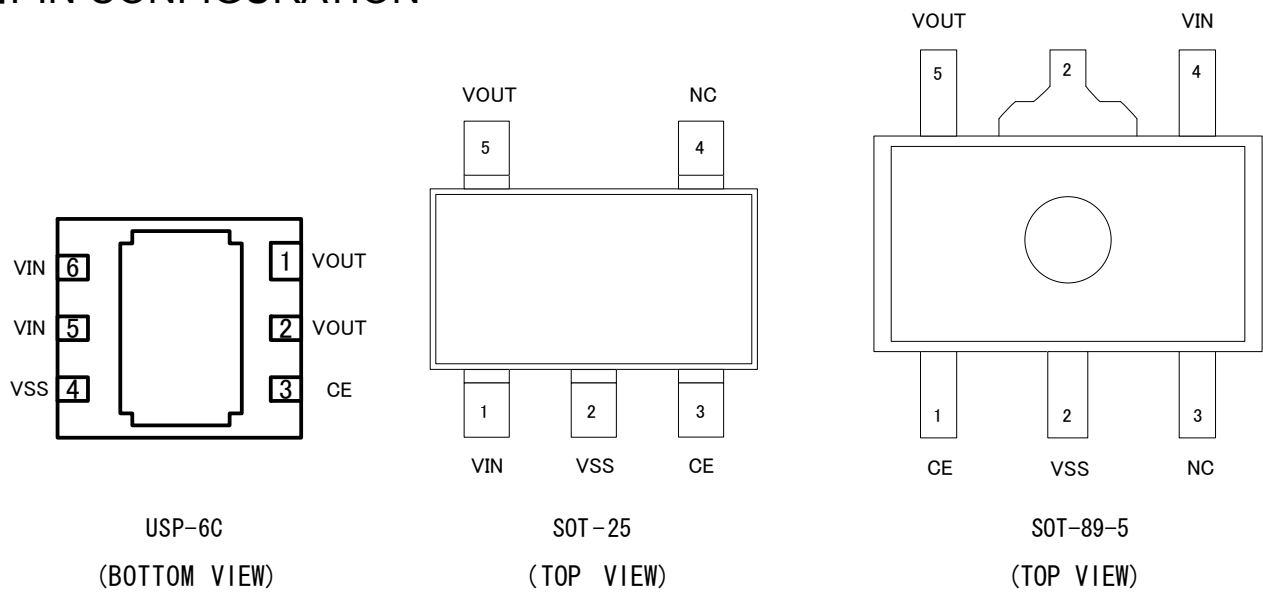


### ■TYPICAL PERFORMANCE CHARACTERISTICS

XC6220x181



## PIN CONFIGURATION



\* The No.5 and 6  $V_{IN}$  pins should be connected. The No.1 and 2 pins  $V_{OUT}$  pins should be connected. The dissipation pad for the USP-6C package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the  $V_{SS}$  (No. 4)

## PIN ASSIGNMENT

PIN NUMBER			PIN NAME	FUNCTIONS
SOT-25	SOT-89-5	USP-6C		
3	1	3	CE	ON/OFF Control
1	4	6 & 5	$V_{IN}$	Power Input
2	2	4	$V_{SS}$	Ground
5	5	1 & 2	$V_{OUT}$	Output
4	3	-	NC	No connection

## ■ PRODUCT CLASSIFICATION

### ● Selection Guide

Please see the optional setting for  $C_L$  discharge and internal CE pull-down.

PRODUCT NAME	CONDITIONS
XC6220A	without CE Pull-down resistor, without $C_L$ auto discharge (Semi-custom)
XC6220B	without CE Pull-down resistor, with $C_L$ auto discharge (Standard)
XC6220C	with CE Pull-down resistor, without $C_L$ auto discharge (Semi-custom)
XC6220D	with CE Pull-down resistor, with $C_L$ auto discharge (Semi-custom)

### ● Ordering Information

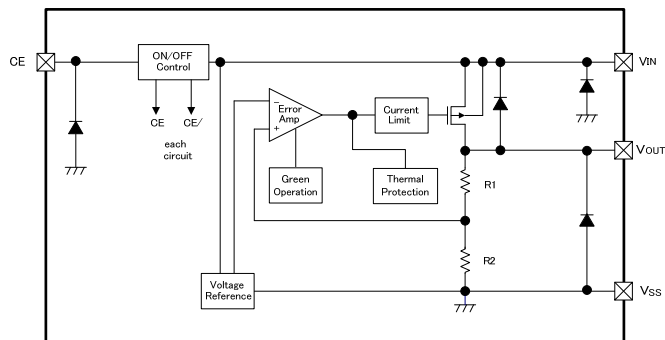
XC6220 ①②③④⑤⑥-⑦<sup>(\*)</sup>

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
①	Type of CE	A	without CE Pull-down resistor, without $C_L$ discharge (Semi-custom)
		B	without CE Pull-down resistor, with $C_L$ discharge (Standard)
		C	with CE Pull-down resistor, without $C_L$ discharge (Semi-custom)
		D	with CE Pull-down resistor, with $C_L$ discharge (Semi-custom)
② ③	Output Voltage	08~50	e.g. 3.0V → ①=3, ②=0
④	Output Voltage Accuracy	1	Output voltage {O.O0v} (the 2 <sup>nd</sup> decimal place is "0") :HS Mode Accuracy $\pm 1\%$ ( $V_{OUT(T)} \geq 2.1V$ ), within 0.02V ( $V_{OUT(T)} \leq 2.0V$ ) :PS Mode Accuracy $\pm 2\%$ ( $V_{OUT(T)} \geq 2.1V$ ), within 0.04V ( $V_{OUT(T)} \leq 2.0V$ )
		B	Output voltage {O.O5v} (the 2 <sup>nd</sup> decimal place is "5") :HS Mode Accuracy $\pm 1\%$ ( $V_{OUT(T)} \geq 2.05V$ ), within 0.02V ( $V_{OUT(T)} \leq 1.95V$ ) :PS Mode Accuracy $\pm 2\%$ ( $V_{OUT(T)} \geq 2.05V$ ), within 0.04V ( $V_{OUT(T)} \leq 1.95V$ )
⑤⑥-⑦	Packages Taping Type <sup>(*)</sup>	MR	SOT-25
		MR-G	SOT-25
		PR	SOT-89-5
		PR-G	SOT-89-5
		ER	USP-6C
		ER-G	USP-6C

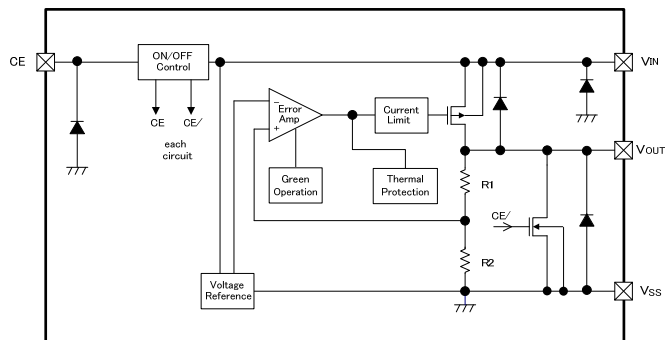
<sup>(\*)</sup> The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.

<sup>(\*)</sup> The device orientation is fixed in its embossed tape pocket. For reverse orientation, please contact your local Torex sales office or representative. (Standard orientation: ⑤R-⑦, Reverse orientation: ⑤L-⑦)

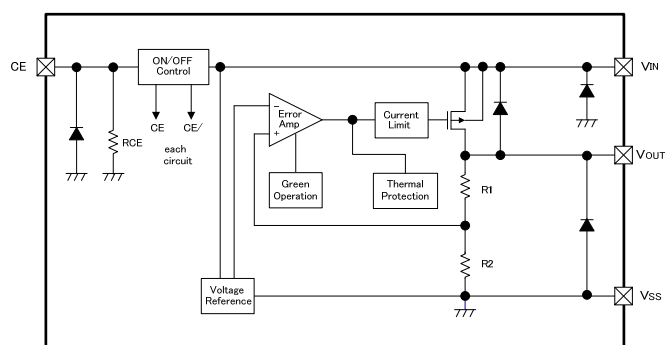
## BLOCK DIAGRAMS



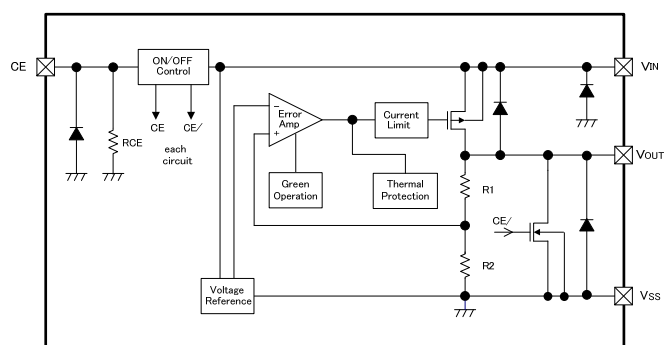
●XC6220A Series (Semi-custom)



●XC6220B Series



●XC6220C Series (Semi-custom)



●XC6220D Series (Semi-custom)

\* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

## ABSOLUTE MAXIMUM RATINGS

Ta=25°C

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		V <sub>IN</sub>	6.5	V
Output Current <sup>(*1)</sup>		I <sub>OUT</sub>	1400	mA
Output Voltage		V <sub>OUT</sub>	V <sub>SS</sub> -0.3 ~ V <sub>IN</sub> +0.3	V
CE Input Voltage		V <sub>CE</sub>	V <sub>SS</sub> -0.3 ~ 6.5	V
Power Dissipation	SOT-25	Pd	250	mW
	SOT-89-5		600 (PCB mounted) <sup>(*2)</sup>	
			500	
			1300 (PCB mounted) <sup>(*2)</sup>	
	USP-6C		120	
		1000 (PCB mounted) <sup>(*2)</sup>		
Operating Temperature Range		T <sub>opr</sub>	- 40 ~ + 85	°C
Storage Temperature Range		T <sub>stg</sub>	- 55 ~ + 125	°C

\*1 Please use within the range of  $I_{OUT} = P_d / (V_{IN} - V_{OUT})$

\*2: The power dissipation figure shown is PCB mounted. Please refer to pages 15~17 for details.

## ■ ELECTRICAL CHARACTERISTICS

● XC6220A/B/C/D Series

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	$V_{OUT(E)}$ (2)	High Speed Mode (HS) $2.0V \leq V_{OUT(T)} \leq 5.0V$ $V_{CE}=V_{IN}$ , $I_{OUT}=30mA$	$\times 0.99$	$V_{OUT(T)}$ (3)	$\times 1.01$	V	①
		High Speed Mode (HS) $0.8V \leq V_{OUT(T)} \leq 1.95V$ $V_{CE}=V_{IN}$ , $I_{OUT}=30mA$	-0.02		+0.02		
		Power Save Mode (PS) $2.0V \leq V_{OUT(T)} \leq 5.0V$ $V_{CE}=V_{IN}$ , $I_{OUT}=0.1mA$	$\times 0.98$		$\times 1.02$		
		Power Save Mode (PS) $0.8V \leq V_{OUT(T)} \leq 1.95V$ $V_{CE}=V_{IN}$ , $I_{OUT}=0.1mA$	-0.04		+0.04		
Output Current	$I_{OUTMAX}$	High Speed Mode(HS), $V_{CE}=V_{IN}$ $V_{IN}=V_{OUT(T)}+1.0V$ $0.8V \leq V_{OUT(T)} \leq 1.15V$	700	1200	-	mA	①
		High Speed Mode(HS), $V_{CE}=V_{IN}$ $V_{IN}=V_{OUT(T)}+1.0V$ $1.2V \leq V_{OUT(T)} \leq 5.0V$	1000	1200	-		
Load Regulation	$\Delta V_{OUT}$	High Speed Mode (HS), $V_{CE}=V_{IN}$ $10mA \leq I_{OUT} \leq 300mA$	-	10	45	mV	①
Dropout Voltage1 (*4)	Vdif	High Speed Mode (HS) $I_{OUT}=300mA$ , $V_{CE}=V_{IN}$	see the Voltage Chart			mV	①
Dropout Voltage2 (*4)	Vdif	High Speed Mode(HS) $I_{OUT}=1000mA$ , $V_{CE}=V_{IN}$	see the Voltage Chart			mV	①
Supply Current 1	$I_{SS1}$	High Speed Mode(HS) $V_{IN}=V_{CE}=V_{OUT(T)}+1.0V$ $I_{OUT}=10mA$ (A/B Series)	-	50	108	$\mu A$	②
		High Speed Mode(HS) $V_{IN}=V_{CE}=V_{OUT(T)}+1.0V$ $I_{OUT}=10mA$ (C/D Series)	-	50	see the Voltage Chart		
Supply Current 2	$I_{SS2}$	Power Save Mode(PS) $V_{IN}=V_{CE}=V_{OUT(T)}+1.0V$ $I_{OUT}=0.1mA$	-	8	18	$\mu A$	②
		Power Save Mode(PS) $V_{IN}=V_{CE}=V_{OUT(T)}+1.0V$ $I_{OUT}=0.1mA$	-	8	see the Voltage Chart		
Stand-by Current	$I_{STBY}$	$V_{IN}=6.0V$ , $V_{CE}=V_{SS}$	-0.1	0.01	0.1	$\mu A$	②
Line Regulation	$\frac{\Delta V_{OUT}}{(\Delta V_{IN} \cdot V_{OUT})}$	$V_{OUT(T)}+0.5V \leq V_{IN} \leq 6.0V$ : $1.1V \leq V_{OUT(T)} \leq 5.0V$ High Speed Mode (HS), $V_{CE}=V_{IN}$ $I_{OUT}=100mA$	-	0.01	0.20	%V	①
		$1.6V \leq V_{IN} \leq 6.0V$ : $0.8V \leq V_{OUT(T)} \leq 1.05V$ High Speed Mode (HS), $V_{CE}=V_{IN}$ $I_{OUT}=100mA$					
Input Voltage	$V_{IN}$		1.6	-	6.0	V	
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{(\Delta Ta \cdot V_{OUT})}$	High Speed Mode (HS), $V_{CE}=V_{IN}$ $I_{OUT}=30mA$ $-40^\circ C \leq Ta \leq 85^\circ C$	-	$\pm 100$	-	ppm/°C	①

## ELECTRICAL CHARACTERISTICS (Continued)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Ripple Rejection Rate	PSRR	$V_{IN}=5.75V_{DC}+0.5V_{p-pAC}$ $:4.75V \leq V_{OUT(T)} \leq 5.0V$ High Speed Mode (HS), $V_{CE}=V_{IN}$ $I_{OUT}=30mA$ , $f=1kHz$	-	50	-	dB	③
		$V_{IN}=[V_{OUT(T)}+1.0]$ $V_{DC}+0.5V_{p-pAC}$ $:0.85V \leq V_{OUT(T)} \leq 4.7V$ High Speed Mode (HS), $V_{CE}=V_{IN}$ $I_{OUT}=30mA$ , $f=1kHz$					
		$V_{IN}=1.85V_{DC}+0.5V_{p-pAC}$ $:V_{OUT(T)}=0.8V$ High Speed Mode (HS), $V_{CE}=V_{IN}$ $I_{OUT}=30mA$ , $f=1kHz$					
Limit Current	$I_{LIM}$	$V_{CE}=V_{IN}=V_{OUT(T)}+1.0V$ $0.8V \leq V_{OUT(T)} \leq 1.15V$	705	1200	-	mA	①
		$V_{CE}=V_{IN}$ $V_{IN}=V_{OUT(T)}+1.0V$ $1.2V \leq V_{OUT(T)} \leq 5.0V$	1005	1200	-		
Short Current	$I_{SHORT}$	$V_{CE}=V_{IN}$ Short $V_{OUT}$ to $V_{SS}$ level	-	180	-	mA	①
PS Switching Current	$I_{GOR}$	$:1.45V \leq V_{OUT(T)} \leq 5.0V$ $V_{IN}=V_{OUT(T)}+1.0V$ , $V_{CE}="H"$ Level $:0.8V \leq V_{OUT(T)} \leq 1.4V$ $V_{IN}=1.6V$ , $V_{CE}="H"$ Level $I_{OUT}=\text{heavy to light load}$	1.0	2.0	-	mA	⑤
HS Switching Current	$I_{GO}$	$:1.45V \leq V_{OUT(T)} \leq 5.0V$ $V_{IN}=V_{OUT(T)}+1.0V$ , $V_{CE}="H"$ Level $:0.8V \leq V_{OUT(T)} \leq 1.4V$ $V_{IN}=1.6V$ , $V_{CE}="H"$ Level $I_{OUT}=\text{light to heavy load}$	-	5.0	10	mA	⑤
Switch Current Hysteresis Range	$I_{GOhys}$	$I_{GOhys}=I_{GO}-I_{GOR}$	-	3.0	-	mA	⑤
PS Switching Delay Time	$t_{DPS}$	$V_{CE}=V_{IN}=V_{OUT(T)}+1.0V$ , (HS/PS Auto-Switching) Time until HS mode is changed-over to PS mode by $I_{GOR}$ .	see the Voltage Chart			$\mu s$	⑤
CE High Level Voltage	$V_{CEH}$	$V_{CE}=V_{IN}$	1.2	-	6.0	V	④
CE Low Level Voltage	$V_{CEL}$	$V_{CE}=V_{SS}$	-	-	0.4	V	④
CE High Level Current	$I_{CEH}$	$V_{CE}=V_{IN}$ (A/B series)	-0.1	-	0.1	$\mu A$	④
		$V_{CE}=V_{IN}=6.0V$ (C/D series)	-	9	15	$\mu A$	
CE Low Level Current	$I_{CEL}$	$V_{CE}=V_{SS}$	-0.1	-	0.1	$\mu A$	④
CL Discharge Resistance <sup>(7)</sup>	$R_{DCHG}$	$V_{IN}=6.0V$ , $V_{OUT}=5.0V$ , $V_{CE}=V_{SS}$	-	460	-	$\Omega$	①
Thermal Shutdown Detect Temperature	$T_{TSD}$	Junction Temperature	-	150	-	$^{\circ}C$	
Thermal Shutdown Release Temperature	$T_{TSR}$	Junction Temperature	-	135	-	$^{\circ}C$	
Inrush Current	$I_{RUSH}$	$V_{IN}=V_{OUT(T)}+1.0V$ , $C_L=22\mu F$ $V_{CE}=0V \rightarrow V_{OUT(T)}+1.0V$ (Only when rising and within 1ms)	-	-	700	mA	⑥

### NOTE:

\*1: Unless otherwise stated,  $V_{IN}=V_{OUT(T)}+1.0V$ .

\*2:  $V_{OUT(E)}$  = Effective output voltage (see the voltage chart)

(ie. The output voltage when " $V_{OUT(T)}+1.0V$ " is provided at the  $V_{IN}$  pin while maintaining a certain  $I_{OUT}$  value.

\*3:  $V_{OUT(T)}$ : Nominal output voltage

\*4:  $V_{dif}=\{V_{IN1}^{(6)} - V_{OUT1}^{(5)}\}$

\*5:  $V_{OUT1}$ =A voltage equal to 98% of the  $V_{OUT(T)}$  when an amply stabilized  $I_{OUT}$  ( $V_{OUT(T)}+1.0V$ ) is input in the HS mode.

\*6:  $V_{IN1}$ =The input voltage when  $V_{OUT1}$  appears as input voltage is gradually decreased.

\*7: For the XC6220B/D series only. The XC6220A/C series (semi-custom) discharges by resistors R1 and R2 only as shown in the block diagrams.

\*8: For the XC6220A/C series, output voltage rises when the IC is in the high temperature stand-by mode.

## ■ ELECTRICAL CHARACTERISTICS (Continued)

● Voltage Chart 1

NOMINAL OUTPUT VOLTAGE (V)	OUTPUT VOLTAGE 1 (HS Mode) (V)		OUTPUT VOLTAGE 2 (PS Mode) (V)		DROPOUT VOLTAGE 1 Vdif 1 (mV) I <sub>OUT</sub> =300mA		DROPOUT VOLTAGE 2 Vdif 2 (mV) I <sub>OUT</sub> =1000mA		SUPPLY CURRENT 1 (XC6220C/D ) (μA)	SUPPLY CURRENT 2 (XC6220C/D ) (μA)	PS SWITCH DELAY TIME (μs)
	V <sub>OUT</sub>		V <sub>OUT</sub>		Vdif		Vdif		I <sub>SS1</sub>	I <sub>SS2</sub>	t <sub>DPS</sub>
V <sub>OUT(T)</sub>	MIN.	MAX.	MIN.	MAX.	TYP.	MAX.	MAX.		MAX.	MAX.	MAX.
0.80	0.7800	0.8200	0.7600	0.8400	400	575	—		112.500	22.500	650
0.85	0.8300	0.8700	0.8100	0.8900					112.625	22.625	
0.90	0.8800	0.9200	0.8600	0.9400					112.750	22.750	
0.95	0.9300	0.9700	0.9100	0.9900					112.875	22.875	
1.00	0.9800	1.0200	0.9600	1.0400	240	405			113.000	23.000	
1.05	1.0300	1.0700	1.0100	1.0900					113.125	23.125	
1.10	1.0800	1.1200	1.0600	1.1400	180	305			113.250	23.250	
1.15	1.1300	1.1700	1.1100	1.1900					113.375	23.375	
1.20	1.1800	1.2200	1.1600	1.2400	150	215	460		113.500	23.500	
1.25	1.2300	1.2700	1.2100	1.2900					113.625	23.625	
1.30	1.2800	1.3200	1.2600	1.3400					113.750	23.750	
1.35	1.3300	1.3700	1.3100	1.3900					113.875	23.875	
1.40	1.3800	1.4200	1.3600	1.4400					114.000	24.000	
1.45	1.4300	1.4700	1.4200	1.4800					114.125	24.125	
1.50	1.4800	1.5200	1.4700	1.5300	100	150	655		114.250	24.250	
1.55	1.5300	1.5700	1.5100	1.5900					114.375	24.375	
1.60	1.5800	1.6200	1.5600	1.6400					114.500	24.500	
1.65	1.6300	1.6700	1.6100	1.6900					114.625	24.625	
1.70	1.6800	1.7200	1.6600	1.7400					114.750	24.750	
1.75	1.7300	1.7700	1.7100	1.7900					114.875	24.875	
1.80	1.7800	1.8200	1.7600	1.8400	85	130	115.000	25.000			
1.85	1.8300	1.8700	1.8100	1.8900			115.125	25.125			
1.90	1.8800	1.9200	1.8600	1.9400			115.250	25.250			
1.95	1.9300	1.9700	1.9100	1.9900			115.375	25.375			
2.00	1.9800	2.0200	1.9600	2.0400			115.500	25.500			
2.05	2.0295	2.0705	2.0090	2.0910			115.625	25.625			
2.10	2.0790	2.1210	2.0580	2.1420			115.750	25.750			
2.15	2.1285	2.1715	2.1070	2.1930			115.875	25.875			
2.20	2.1780	2.2220	2.1560	2.2440			116.000	26.000			
2.25	2.2275	2.2725	2.2050	2.2950			116.125	26.125			
2.30	2.2770	2.3230	2.2540	2.3460			116.250	26.250			
2.35	2.3265	2.3735	2.3030	2.3970			116.375	26.375			
2.40	2.3760	2.4240	2.3520	2.4480	65	110	116.500	26.500			
2.45	2.4255	2.4745	2.4010	2.4990			116.625	26.625			
2.50	2.4750	2.5250	2.4500	2.5500			116.750	26.750			
2.55	2.5245	2.5755	2.4990	2.6010			116.875	26.875			
2.60	2.5740	2.6260	2.5480	2.6520			117.000	27.000			
2.65	2.6235	2.6765	2.5970	2.7030			117.125	27.125			
2.70	2.6730	2.7270	2.6460	2.7540			117.250	27.250			
2.75	2.7225	2.7775	2.6950	2.8050			117.375	27.375			
2.80	2.7720	2.8280	2.7440	2.8560			117.500	27.500			
2.85	2.8215	2.8785	2.7930	2.9070			117.625	27.625			
2.90	2.8710	2.9290	2.8420	2.9580			117.750	27.750			
2.95	2.9205	2.9795	2.8910	3.0090			117.875	27.875			

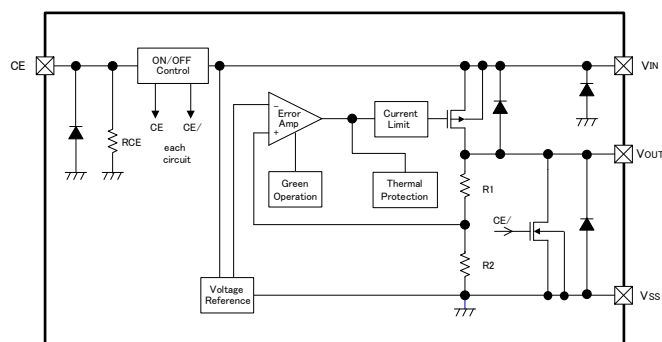
## ELECTRICAL CHARACTERISTICS (Continued)

### ● Voltage Chart 2

NOMINAL OUTPUT VOLTAGE (V)	OUTPUT VOLTAGE (HS Mode) (V)		OUTPUT VOLTAGE (PS Mode) (V)		DROPOUT VOLTAGE 1 Vdif 1 (mV) I <sub>OUT</sub> =300mA		DROPOUT VOLTAGE 2 Vdif 2 (mV) I <sub>OUT</sub> =1000mA		SUPPLY CURRENT 1 (XC6220C/D) (μA)	SUPPLY CURRENT 2 (XC6220C/D) (μA)	PS SWITCH DELAY TIME (μs)
	V <sub>OUT</sub>		V <sub>OUT</sub>		Vdif		Vdif		I <sub>SS1</sub>	I <sub>SS2</sub>	t <sub>DPS</sub>
V <sub>OUT(T)</sub>	MIN.	MAX.	MIN.	MAX.	TYP.	MAX.	MAX.		MAX.	MAX.	MAX.
3.00	2.9700	3.0300	2.9400	3.0600	60	95	655		118.000	28.000	1200
3.05	3.0195	3.0805	2.9890	3.1110					118.125	28.125	
3.10	3.0690	3.1310	3.0380	3.1620					118.250	28.250	
3.15	3.1185	3.1815	3.0870	3.2130					118.375	28.375	
3.20	3.1680	3.2320	3.1360	3.2640					118.500	28.500	
3.25	3.2175	3.2825	3.1850	3.3150					118.625	28.625	
3.30	3.2670	3.3330	3.2340	3.3660					118.750	28.750	
3.35	3.3165	3.3835	3.2830	3.4170					118.875	28.875	
3.40	3.3660	3.4340	3.3320	3.4680					119.000	29.000	
3.45	3.4155	3.4845	3.3810	3.5190					119.125	29.125	
3.50	3.4650	3.5350	3.4300	3.5700					119.250	29.250	
3.55	3.5145	3.5855	3.4790	3.6210					119.375	29.375	
3.60	3.5640	3.6360	3.5280	3.6720					119.500	29.500	
3.65	3.6135	3.6865	3.5770	3.7230					119.625	29.625	
3.70	3.6630	3.7370	3.6260	3.7740					119.750	29.750	
3.75	3.7125	3.7875	3.6750	3.8250					119.875	29.875	
3.80	3.7620	3.8380	3.7240	3.8760					120.000	30.000	
3.85	3.8115	3.8885	3.7730	3.9270					120.125	30.125	
3.90	3.8610	3.9390	3.8220	3.9780					120.250	30.250	
3.95	3.9105	3.9895	3.8710	4.0290					120.375	30.375	
4.00	3.9600	4.0400	3.9200	4.0800	120.500	30.500					
4.05	4.0095	4.0905	3.9690	4.1310	120.625	30.625			1450		
4.10	4.0590	4.1410	4.0180	4.1820	120.750	30.750					
4.15	4.1085	4.1915	4.0670	4.2330	120.875	30.875					
4.20	4.1580	4.2420	4.1160	4.2840	121.000	31.000					
4.25	4.2075	4.2925	4.1650	4.3350	121.125	31.125					
4.30	4.2570	4.3430	4.2140	4.3860	121.250	31.250					
4.35	4.3065	4.3935	4.2630	4.4370	121.375	31.375					
4.40	4.3560	4.4440	4.3120	4.4880	121.500	31.500					
4.45	4.4055	4.4945	4.3610	4.5390	121.625	31.625					
4.50	4.4550	4.5450	4.4100	4.5900	121.750	31.750					
4.55	4.5045	4.5955	4.4590	4.6410	121.875	31.875					
4.60	4.5540	4.6460	4.5080	4.6920	122.000	32.000					
4.65	4.6035	4.6965	4.5570	4.7430	122.125	32.125					
4.70	4.6530	4.7470	4.6060	4.7940	122.250	32.250					
4.75	4.7025	4.7975	4.6550	4.8450	122.375	32.375					
4.80	4.7520	4.8480	4.7040	4.8960	122.500	32.500					
4.85	4.8015	4.8985	4.7530	4.9470	122.625	32.625					
4.90	4.8510	4.9490	4.8020	4.9980	122.750	32.750					
4.95	4.9005	4.9995	4.8510	5.0490	122.875	32.875					
5.00	4.9500	5.0500	4.9000	5.1000	123.000	33.000					



## ■ OPERATIONAL EXPLANATION

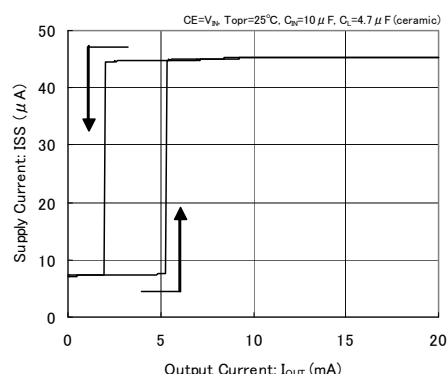


The voltage divided by resistors R1 & R2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET which is connected to the V<sub>OUT</sub> pin is then driven by the subsequent output signal. The output voltage at the V<sub>OUT</sub> pin is controlled & stabilized by a system of negative feedback. The current limit circuit and short protect circuit operate in relation to the level of output current. The GO function monitors the output current and switches the IC between two operating modes according to the level of output current. Further, the IC's internal circuitry can be shutdown via the CE pin's signal.

### <GreenOperation>

The XC6220 series always operates in a green operation (GO) mode. The GO mode enables the IC to switch automatically between the high speed (HS) mode or the power save (PS) mode according to the level of output current. The switching point of the HS mode and the PS mode is fixed inside the IC. When the output current becomes  $I_{GOR}=1.0\text{mA}$  (MIN.) or below, the mode changes automatically to the PS mode after a delay time of hundreds of microseconds. Supply current in light load is greatly reduced. Also when the output current becomes  $I_{GO}$  10mA (MAX.) or more, the mode changes automatically to the HS mode and the IC returns to high speed operation.

**XC6220x301**



### <Low ESR capacitor>

The XC6220 series has a built-in phase compensation circuit which means that a stable output voltage is achieved even if the IC is used with low ESR capacitors. In order to ensure stable phase compensation it is recommended that a  $C_L$  capacitor is connected as close as possible to the V<sub>OUT</sub> pin and V<sub>SS</sub> pin. For a stable power supply, please connect an input capacitor ( $C_{IN}$ ) between the V<sub>IN</sub> pin and the V<sub>SS</sub> pin.

Values required for the phase compensation are shown in the chart below. If a loss of the capacitance happens, the stable phase compensation may not be obtained. Please ensure to use a capacitor which does not depend on bias or temperature too much.

Recommended output capacitor ( $C_L$ ) Values corresponding to input capacitor ( $C_{IN}$ )

OUTPUT VOLTAGE (V)	INPUT CAPACITOR VALUE		
	4.7 $\mu\text{F}$	10 $\mu\text{F}$	22 $\mu\text{F}$
0.80V~0.95V	×	×	22 $\mu\text{F}$
1.00V~1.45V	47 $\mu\text{F}$	47 $\mu\text{F}$	22 $\mu\text{F}$
1.50V~1.75V	47 $\mu\text{F}$	22 $\mu\text{F}$	10 $\mu\text{F}$
1.80V~2.95V	47 $\mu\text{F}$	6.8 $\mu\text{F}$	6.8 $\mu\text{F}$
3.00V~3.50V	47 $\mu\text{F}$	4.7 $\mu\text{F}$	4.7 $\mu\text{F}$
3.55V~5.00V	47 $\mu\text{F}$	10 $\mu\text{F}$	6.8 $\mu\text{F}$

× No option

### <Current Limiter, Short-Circuit Protection>

The XC6220 series includes a fold-back circuit, which aids the operation of the current limiter and circuit protection. When the load current reaches the current limit level, the fold-back circuit operates and output voltage drops. As a result of this drop in output voltage, output current also decreases. When the output pin is shorted, a current of about 180mA flows.

### <CE Pin>

The IC's internal circuitry can be shutdown via the signal from the CE pin with the XC6220 series. With the XC6220B/D series, output at the V<sub>OUT</sub> pin will be pulled down to the V<sub>SS</sub> level. However, with XC6220A/B series, the  $C_L$  auto-discharge resistor is connected in parallel to R1 and R2 while the power supply is applied to the V<sub>IN</sub> pin. Therefore, the time until the V<sub>OUT</sub> pin reaches the V<sub>SS</sub> level is shortened. The output voltage becomes unstable, when the CE pin is open. If this IC is used with the correct output voltage for the CE pin, the logic is fixed and the IC will operate normally. However, with the XC6220C/D series, supply current may increase as a result of through current in the IC's internal circuitry when medium voltage is input.

## ■ OPERATIONAL EXPLANATION (Continued)

### <CL High Speed Auto-Discharge Function>

The XC6220B/D series can quickly discharge the electric charge at the output capacitor ( $C_L$ ), when a low signal to the CE pin, which enables the whole IC circuit put into an OFF state, is inputted to the CE pin via the N-channel transistor located between the VOUT pin and the VSS pin (cf. BLOCK DIAGRAM). The  $C_L$  auto-discharge resistance value is fixed to  $460\ \Omega$  ( $V_{IN}=6.0V$ ,  $V_{OUT}=5.0V$  at TYP.). The discharge time of the output capacitor ( $C_L$ ) is set by the  $C_L$  auto-discharge resistance ( $R_{DCHG}$ ) and the output capacitor ( $C_L$ ). By setting a time constant of the  $C_L$  auto-discharge resistance value [ $R_{DCHG}$ ] and an output capacitor value ( $C_L$ ) as  $\tau$  ( $\tau = C \times R_{DCHG}$ ), the output voltage after discharge via the N channel transistor is calculated by the following formulas.

$$V = V_{OUT} \times e^{-t/\tau}, \quad \text{or } t = \tau \ln(V_{OUT(E)} / V)$$

where

$V$  : Output voltage after discharge

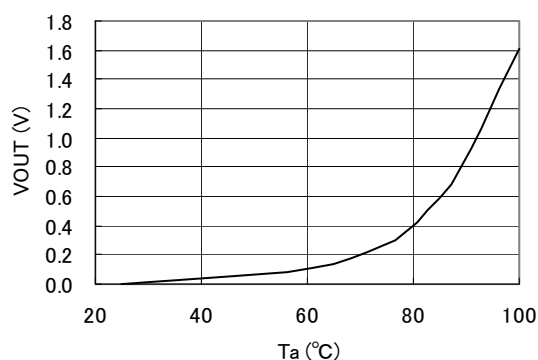
$V_{OUT(E)}$  : Output voltage

$t$  : Discharge time

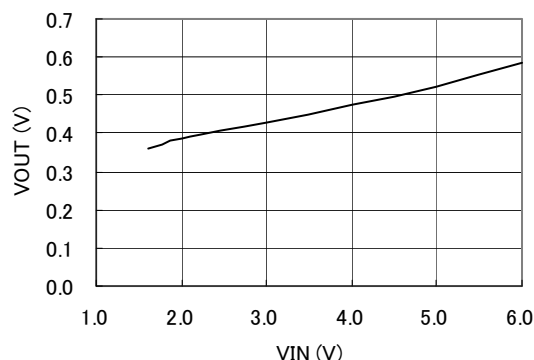
$\tau$  :  $C_L$  auto-discharge resistance  $R_{DCHG} \times$  Output capacitor ( $C_L$ ) value  $C$

For the XC6220A/C series, output voltage may rises when in the high stand-by mode. Please note that in that case, the typical characteristics may worse. When the XC6220A/C series is used, please be noted the characteristics shown below.

XC6220A501xx



Output Voltage vs. Input Voltage



### <Thermal Shutdown>

When the junction temperature of the built-in driver transistor reaches the temperature limit level ( $150^{\circ}\text{C}$  TYP.), the thermal shutdown circuit operates and the driver transistor will be turned OFF. The IC resumes its operation when the thermal shutdown function is released and the IC's operation is automatically restored because the junction temperature drops to the level of the thermal shutdown release voltage.

### <Inrush Current Protection>

The XC6220 series includes an inrush current protection circuit.

The inrush current protection circuit suppresses inrush current charged to  $C_L$  when the IC starts up to 700 mA (MAX.) for approximately 1 ms.

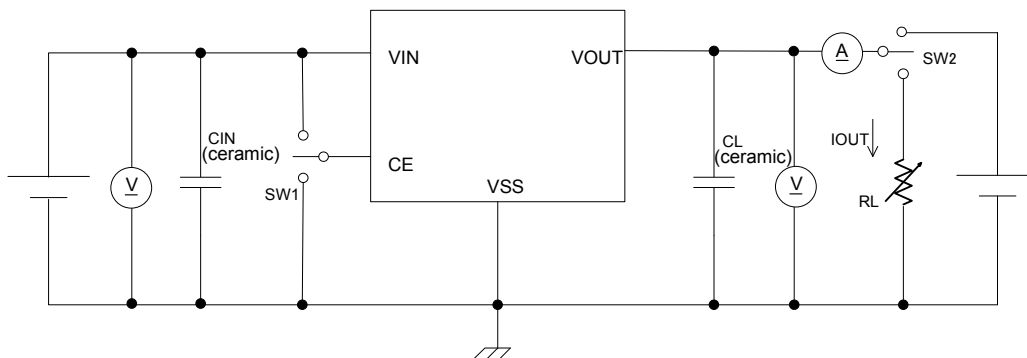
\* Please note that the device can not provide the output current beyond 700 mA for a period of approximately 1 ms after the CE pin goes high.

## ■ NOTES ON USE

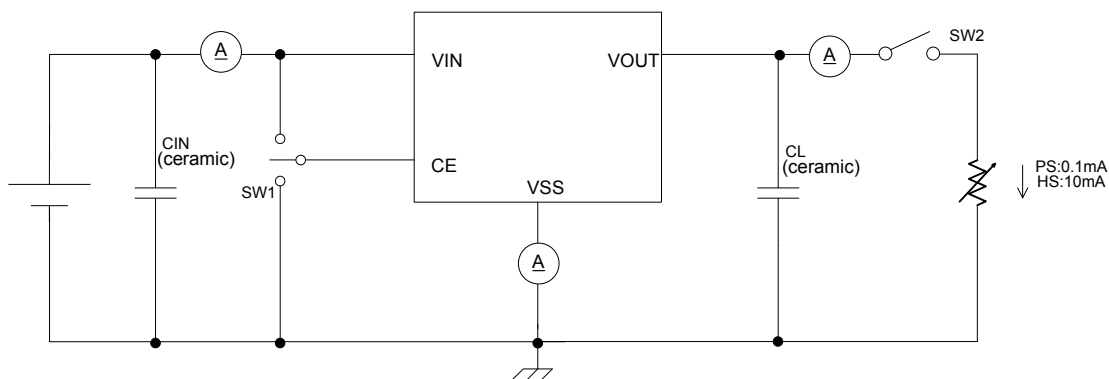
1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded.
2. Where wiring impedance is high, operations may become unstable due to noise and/or phase lag depending on output current. Please strengthen VIN and VSS wiring in particular.
3. Please wire the input capacitor ( $C_{IN}$ ) and the output capacitor ( $C_L$ ) as close to the IC as possible.

## ■ TEST CIRCUITS

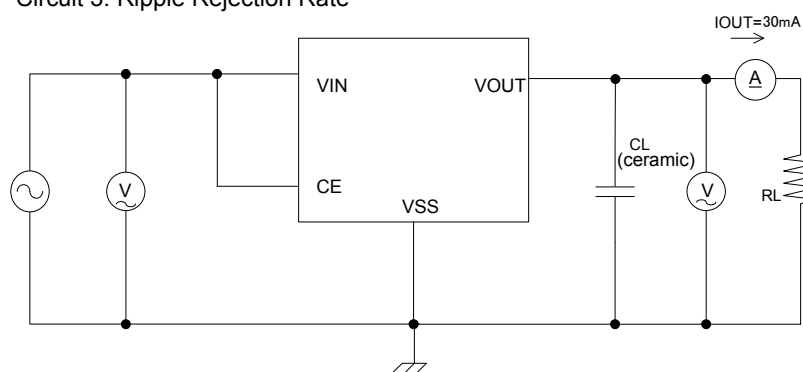
Circuit 1: Output Voltage, Output Current, Dropout Voltage, Input/Operating Voltage, Line Regulation, Load Regulation, Current Limit, Short Current, CL Discharge Resistance



Circuit 2: Supply Current, Stand-by Current

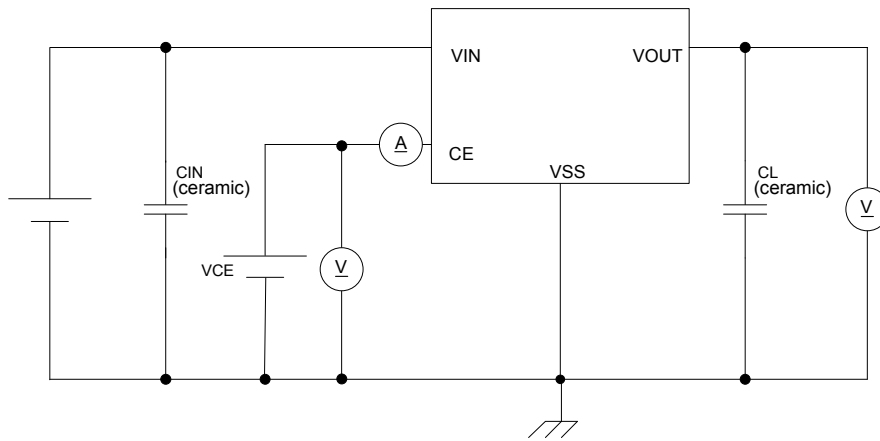


Circuit 3: Ripple Rejection Rate

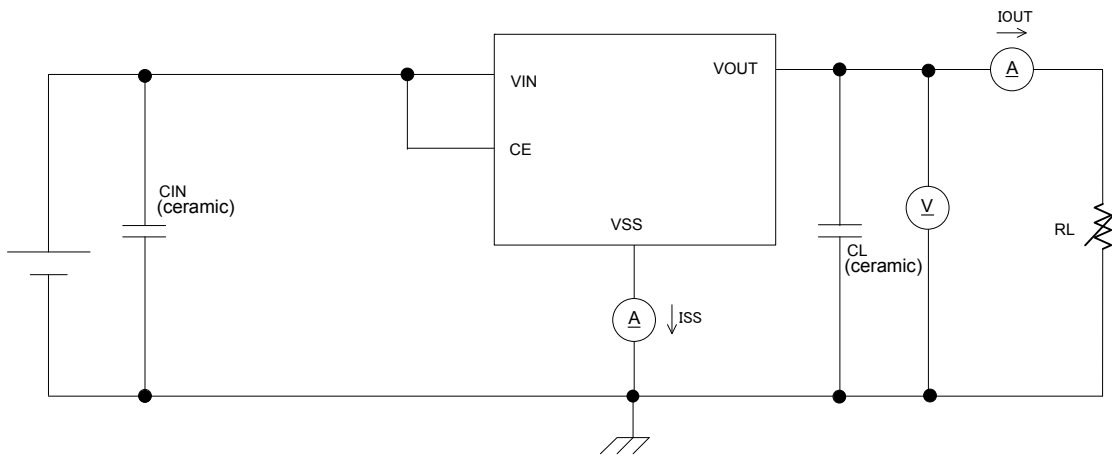


## ■ TEST CIRCUITS (Continued)

Circuit 4: CE “H” “L” Level Voltage, CE “H” “L” Level Current



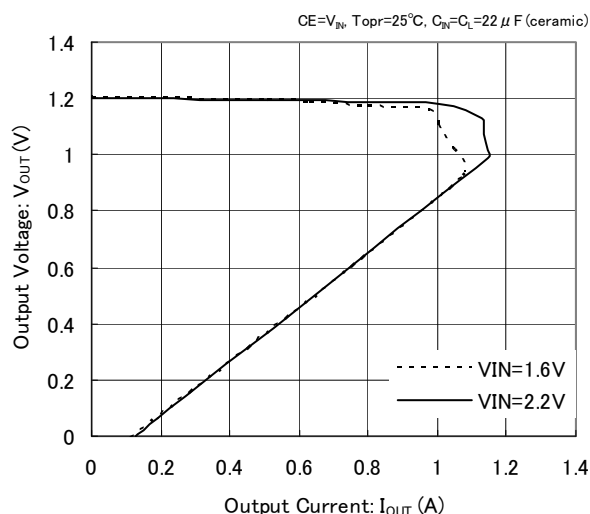
Circuit 5: HS Switching Current, PS Switching Current, Switch Current Hysteresis Range, PS Switching Delay Time



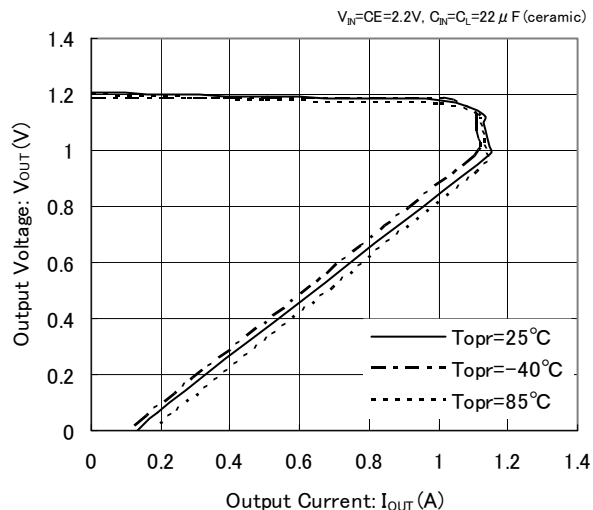
## TYPICAL PERFORMANCE CHARACTERISTICS

### (1) Output Voltage vs. Output Current

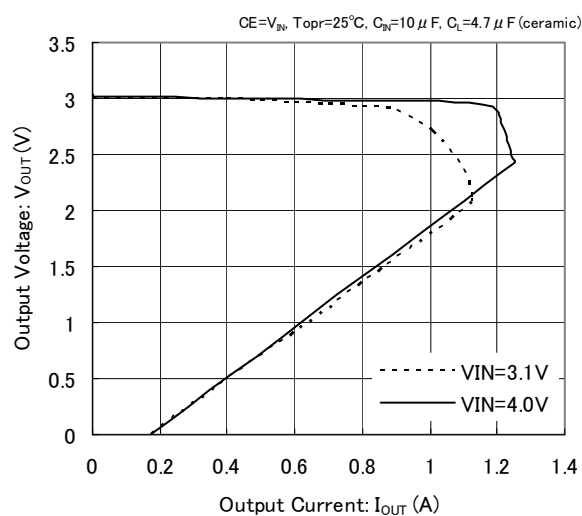
**XC6220x121**



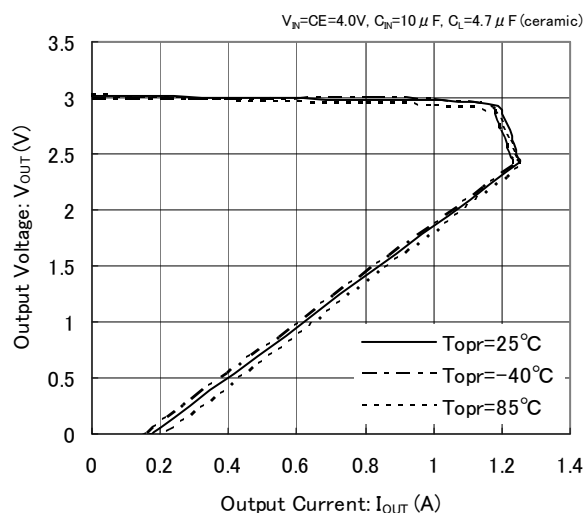
**XC6220x121**



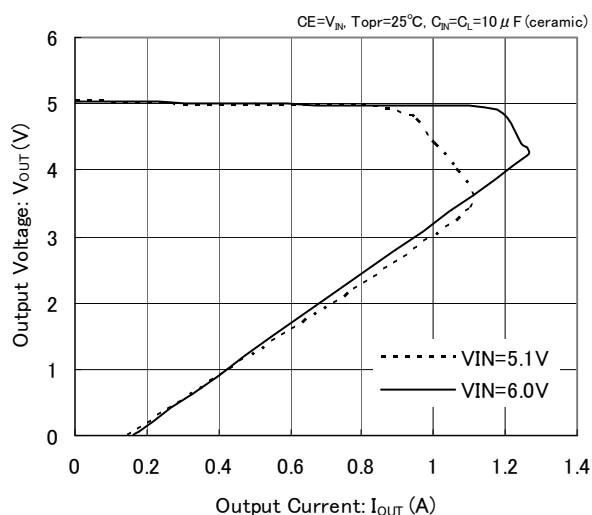
**XC6220x301**



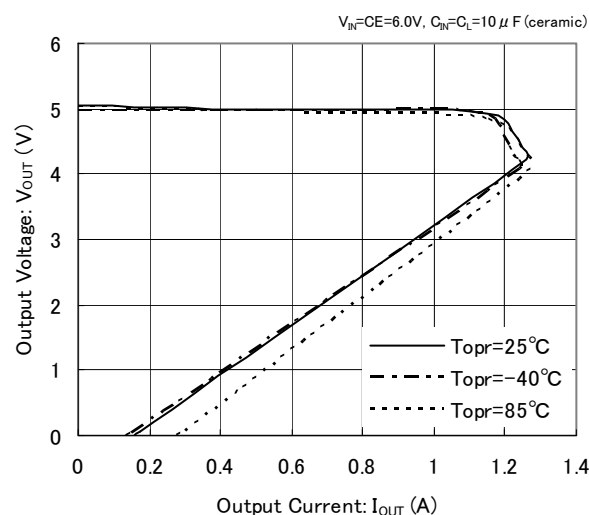
**XC6220x301**



**XC6220x501**



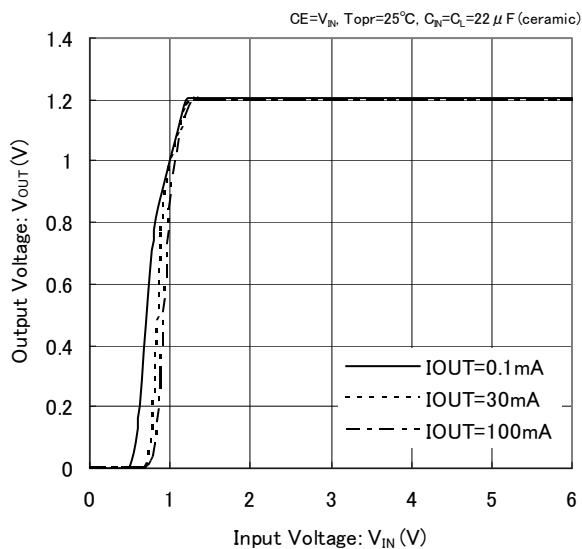
**XC6220x501**



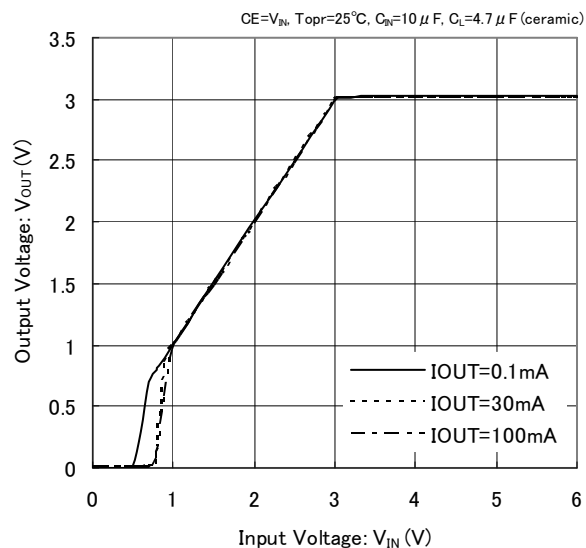
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (2) Output Voltage vs. Input Voltage

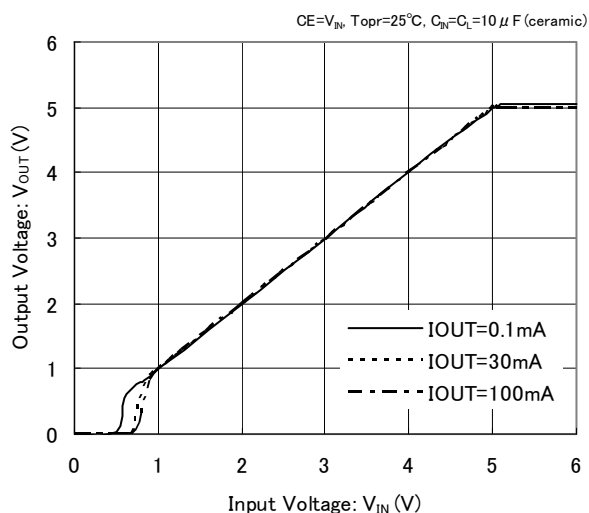
**XC6220x121**



**XC6220x301**

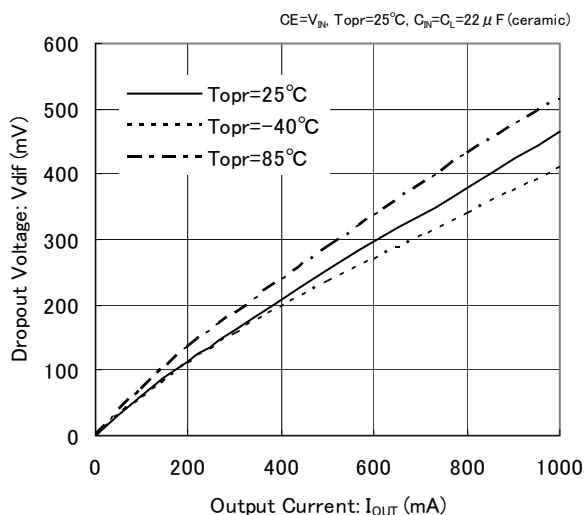


**XC6220x501**

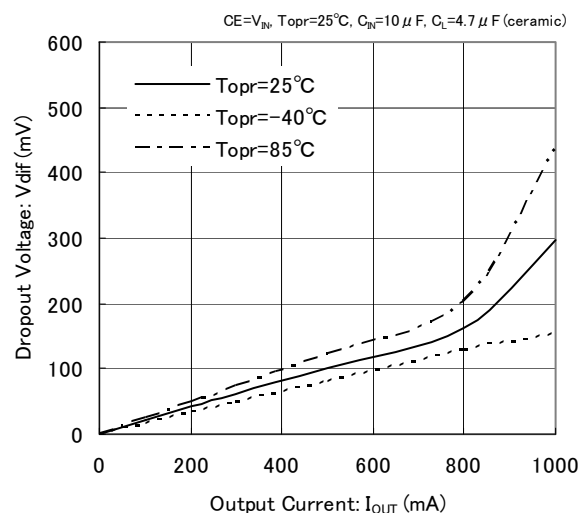


### (3) Dropout Voltage vs. Output Current

**XC6220x121**



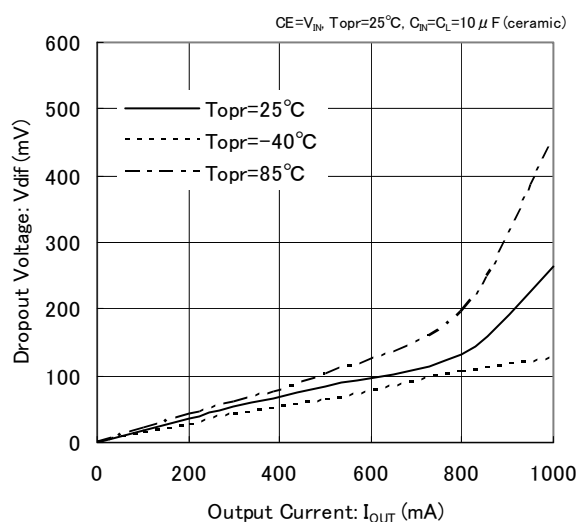
**XC6220x301**



## ■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

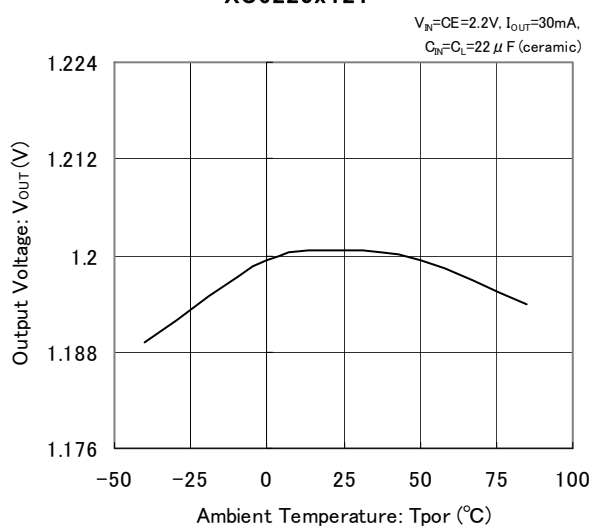
### (3) Dropout Voltage vs. Output Current

#### XC6220x501

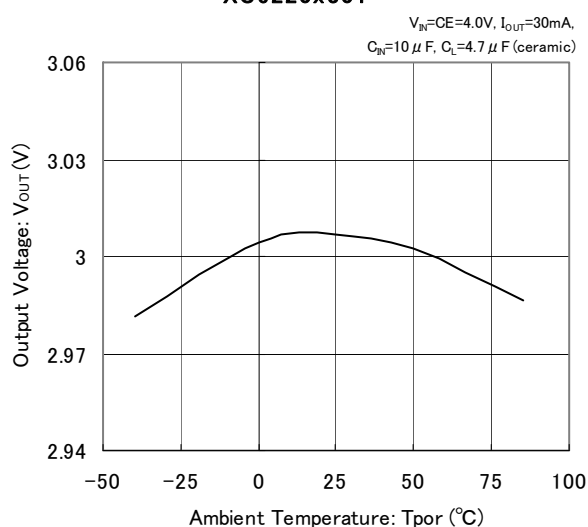


### (4) Output Voltage vs. Ambient Temperature

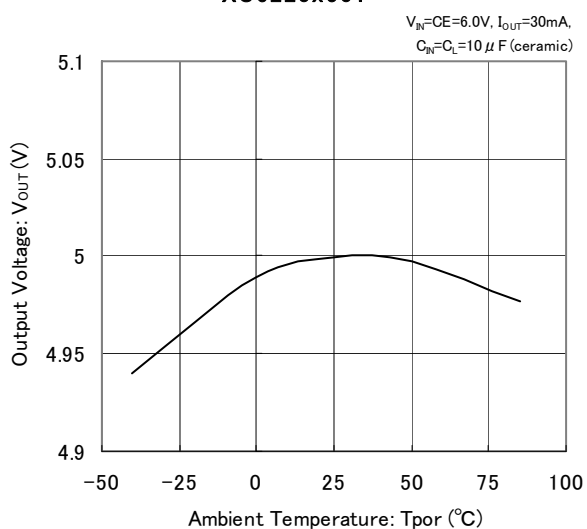
#### XC6220x121



#### XC6220x301



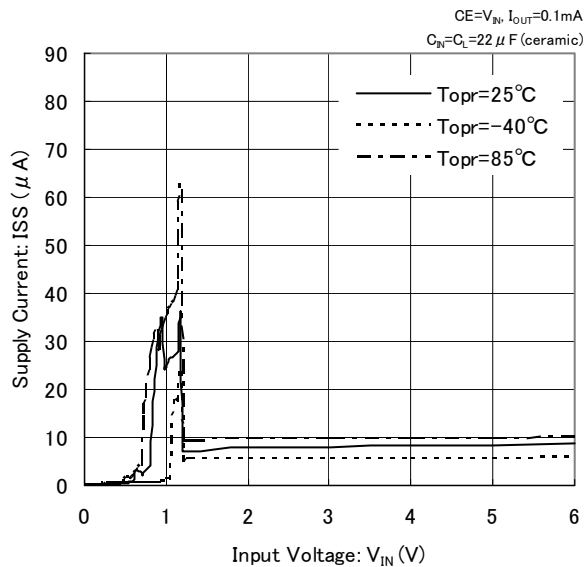
#### XC6220x501



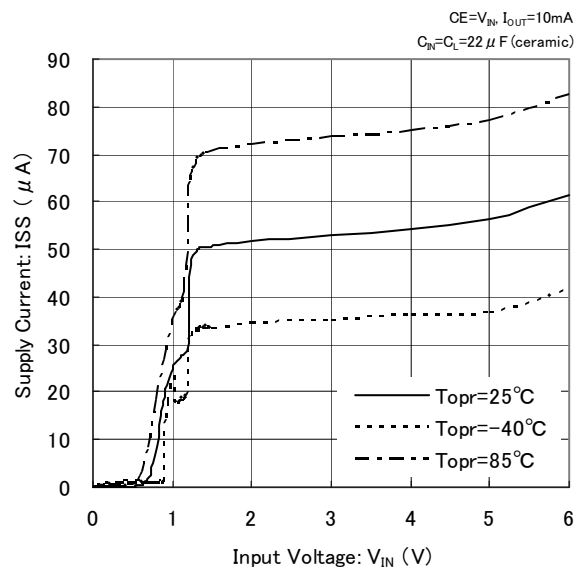
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (5) Supply Current vs. Input Voltage

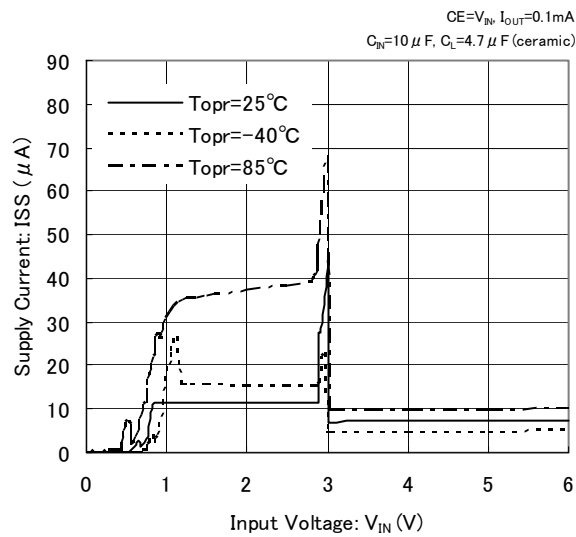
**XC6220x121**



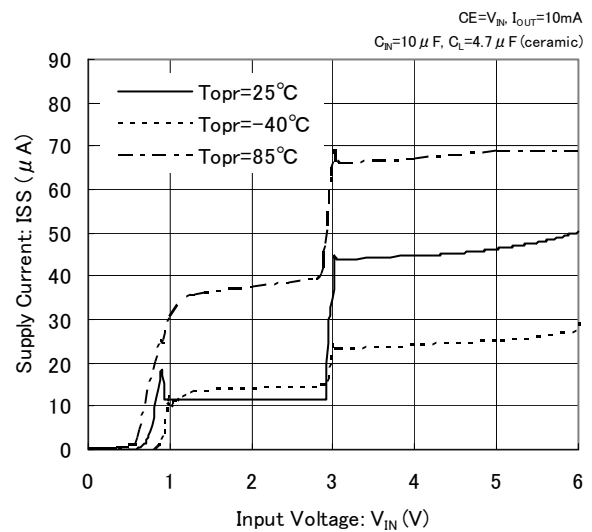
**XC6220B121**



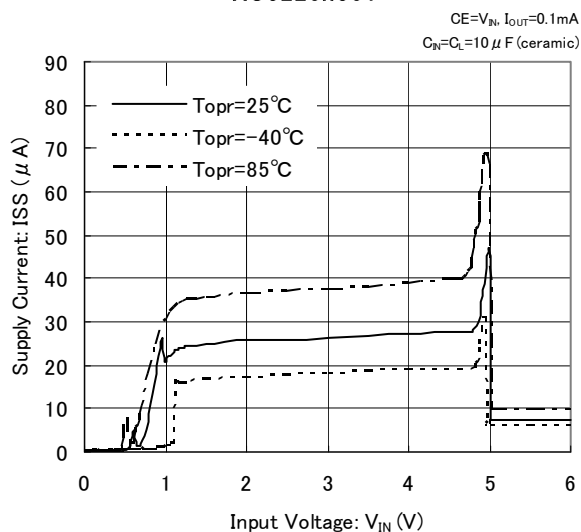
**XC6220x301**



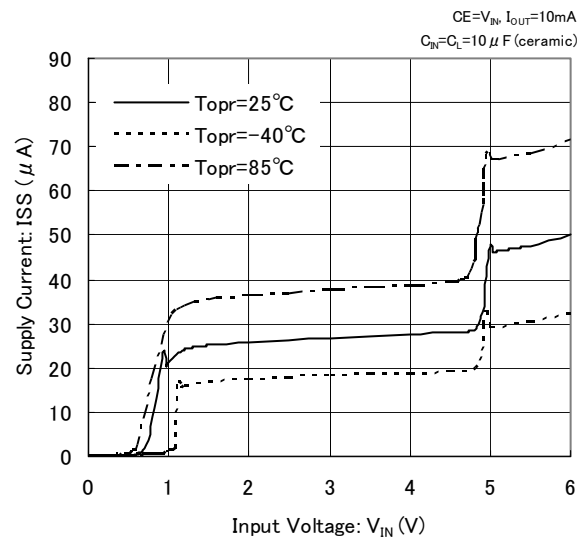
**XC6220x301**



**XC6220x501**



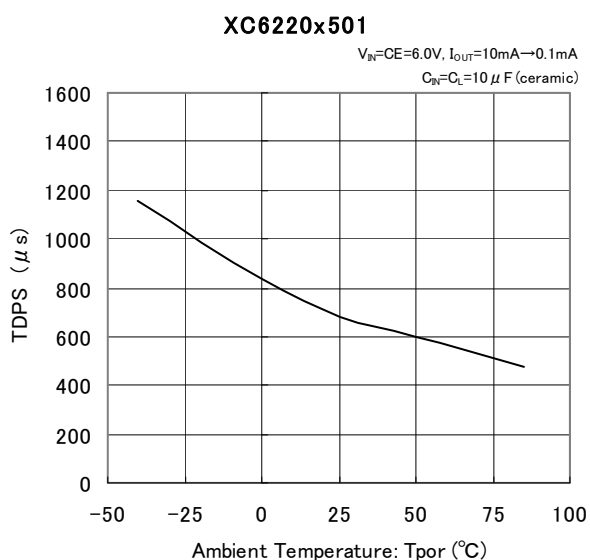
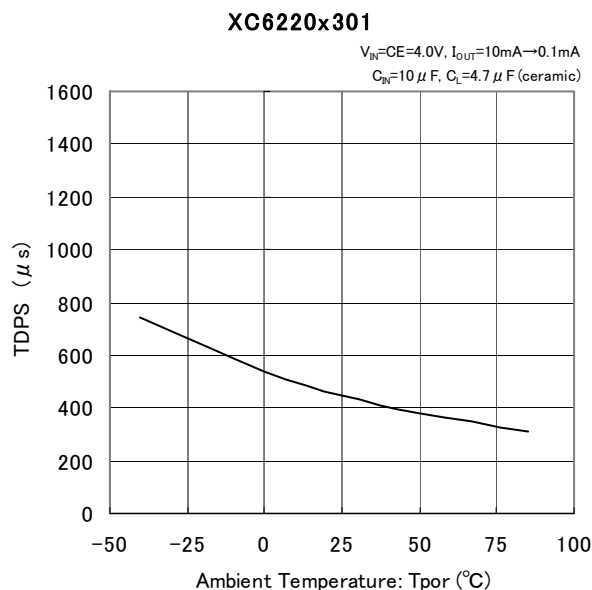
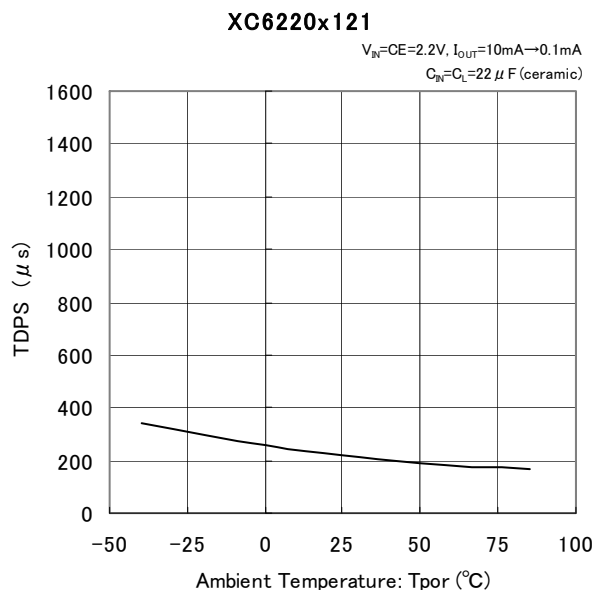
**XC6220x501**



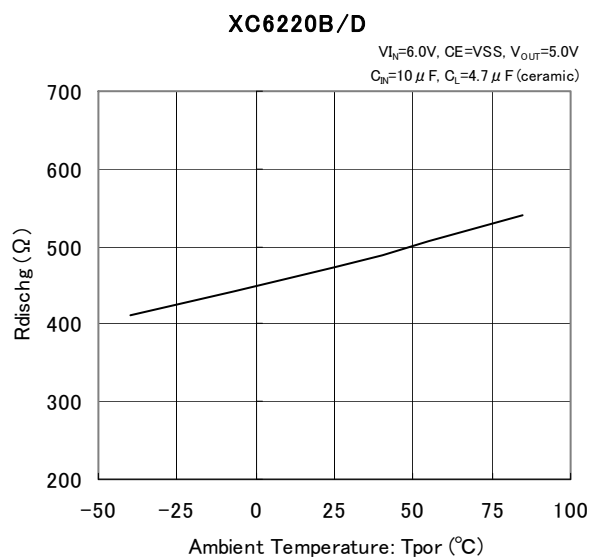


## ■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

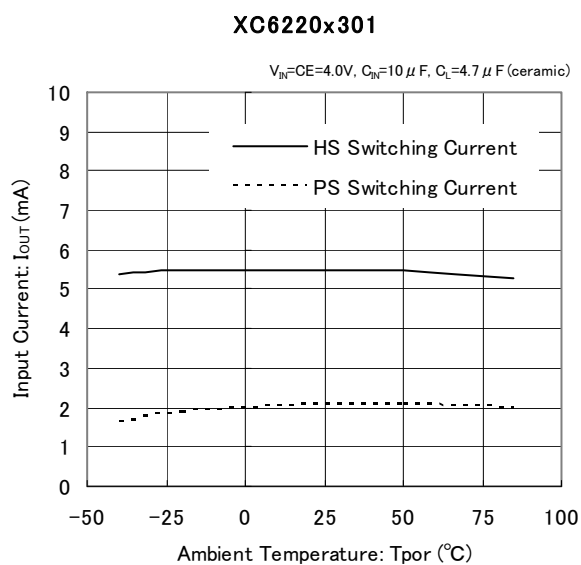
(6) PS Switching Delay Time vs. Ambient Temperature



(7) CL Discharge Resistance vs. Ambient Temperature



(8) PS/HS Switch Current vs. Ambient Temperature

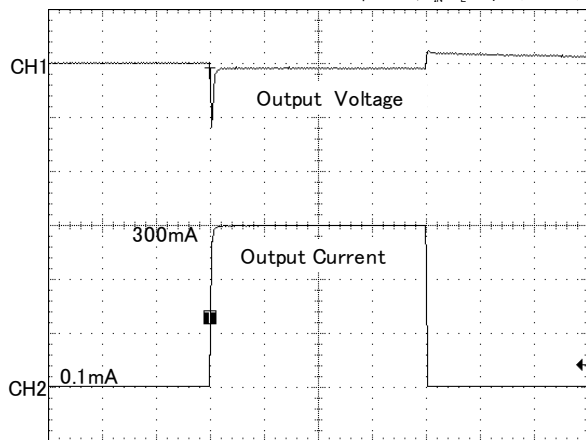


## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (9) Load Transient Response

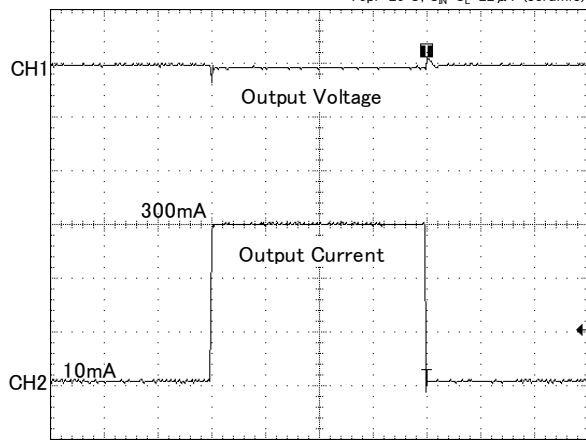
**XC6220x121**

$V_N=CE=2.2V$ ,  $T_r=T_f=5\mu s$   
 $T_{opr}=25^\circ C$ ,  $C_N=C_L=22\mu F$  (ceramic)



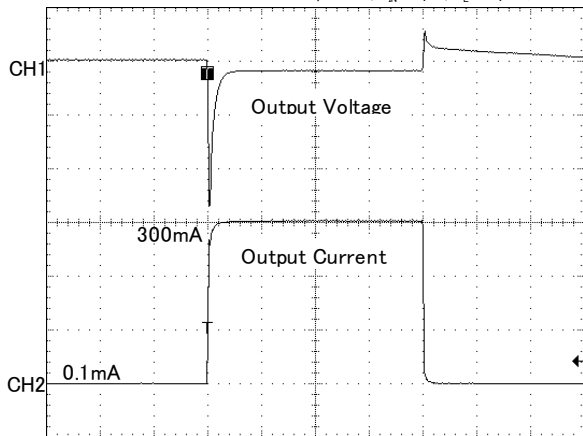
**XC6220x121**

$V_N=CE=2.2V$ ,  $T_r=T_f=5\mu s$   
 $T_{opr}=25^\circ C$ ,  $C_N=C_L=22\mu F$  (ceramic)



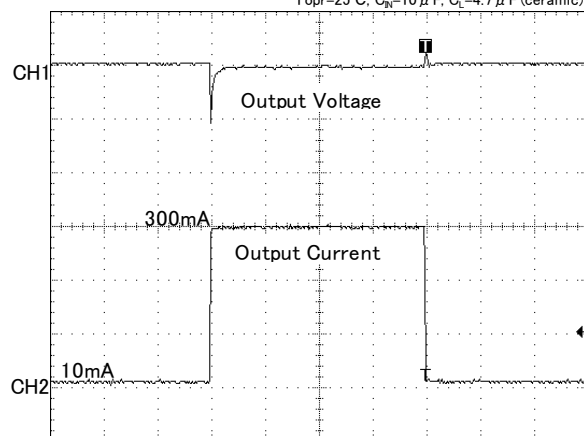
**XC6220x301**

$V_N=CE=4.0V$ ,  $T_r=T_f=5\mu s$   
 $T_{opr}=25^\circ C$ ,  $C_N=10\mu F$ ,  $C_L=4.7\mu F$  (ceramic)



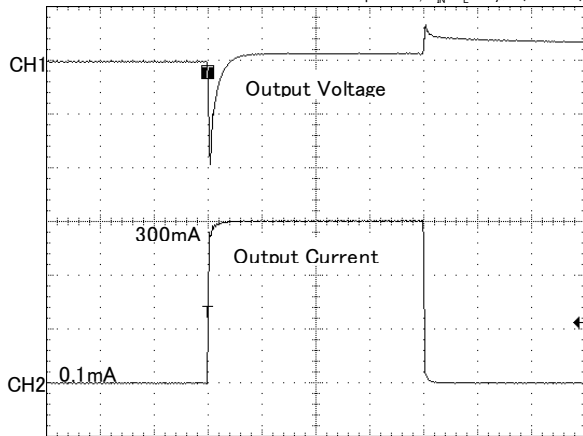
**XC6220x301**

$V_N=CE=4.0V$ ,  $T_r=T_f=5\mu s$   
 $T_{opr}=25^\circ C$ ,  $C_N=10\mu F$ ,  $C_L=4.7\mu F$  (ceramic)



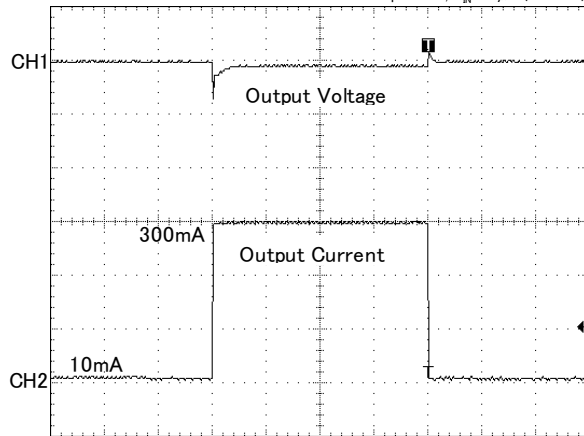
**XC6220x501**

$V_N=CE=6.0V$ ,  $T_r=T_f=5\mu s$   
 $T_{opr}=25^\circ C$ ,  $C_N=C_L=10\mu F$  (ceramic)



**XC6220x501**

$V_N=CE=6.0V$ ,  $T_r=T_f=5\mu s$   
 $T_{opr}=25^\circ C$ ,  $C_N=C_L=10\mu F$  (ceramic)

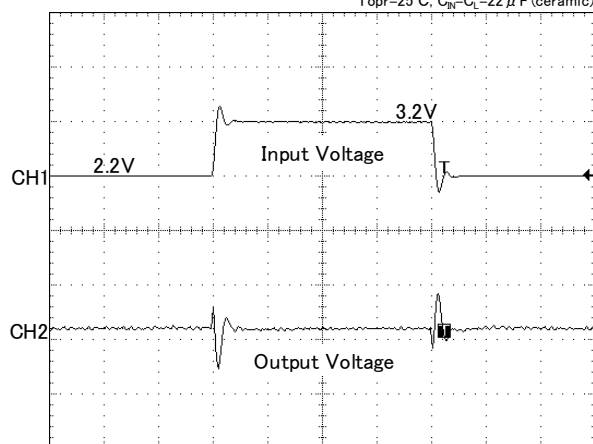


## ■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (10) Line Transient Response

**XC6220x121**

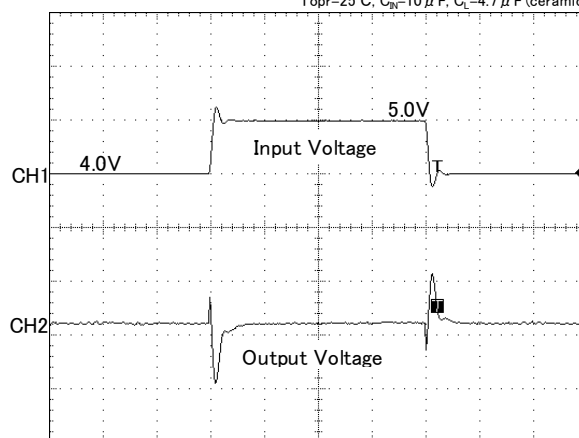
CE=V<sub>IN</sub>, Tr=Tf=5  $\mu$ s, I<sub>OUT</sub>=100mA  
Topr=25°C, C<sub>IN</sub>=C<sub>L</sub>=22  $\mu$ F (ceramic)



100  $\mu$ s/div  
CH1: 1V/div CH2: 20mV/div

**XC6220x301**

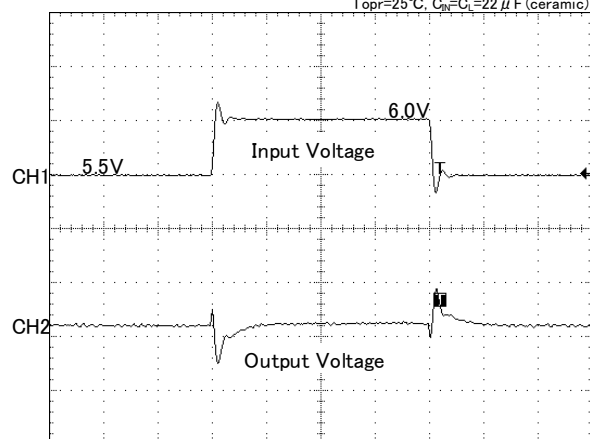
CE=V<sub>IN</sub>, Tr=Tf=5  $\mu$ s, I<sub>OUT</sub>=100mA  
Topr=25°C, C<sub>IN</sub>=10  $\mu$ F, C<sub>L</sub>=4.7  $\mu$ F (ceramic)



100  $\mu$ s/div  
CH1: 1V/div CH2: 20mV/div

**XC6220x501**

CE=V<sub>IN</sub>, Tr=Tf=5  $\mu$ s, I<sub>OUT</sub>=100mA  
Topr=25°C, C<sub>IN</sub>=C<sub>L</sub>=22  $\mu$ F (ceramic)

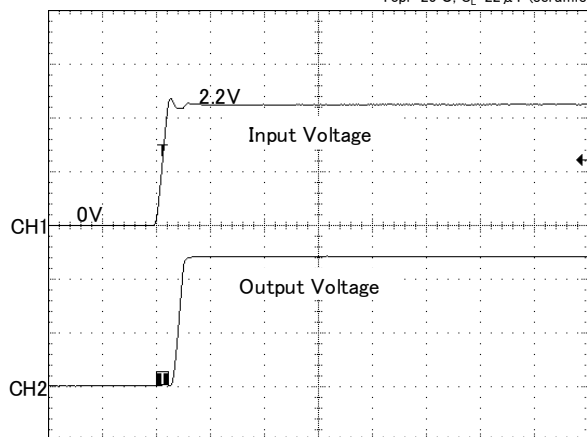


100  $\mu$ s/div  
CH1: 500mV/div CH2: 20mV/div

### (11) Input Rise Characteristics

**XC6220x121**

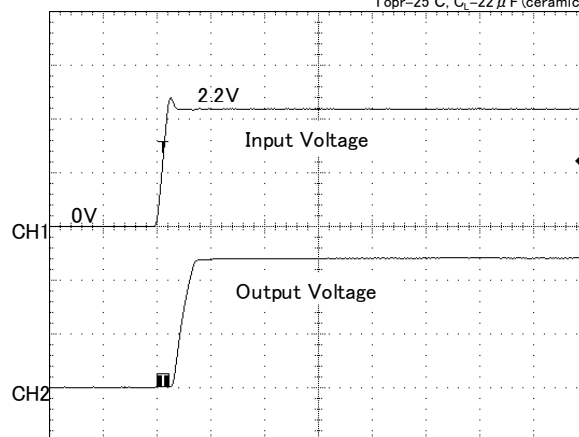
CE=V<sub>IN</sub>, Tr=5  $\mu$ s, I<sub>OUT</sub>=0.1mA  
Topr=25°C, C<sub>L</sub>=22  $\mu$ F (ceramic)



200  $\mu$ s/div  
CH1: 1V/div CH2: 500mV/div

**XC6220x121**

CE=V<sub>IN</sub>, Tr=5  $\mu$ s, I<sub>OUT</sub>=300mA  
Topr=25°C, C<sub>L</sub>=22  $\mu$ F (ceramic)



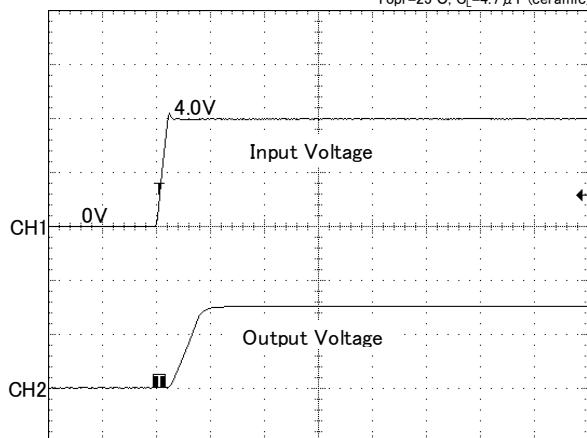
200  $\mu$ s/div  
CH1: 1V/div CH2: 500mV/div

## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (11) Input Rise Characteristics

#### XC6220x301

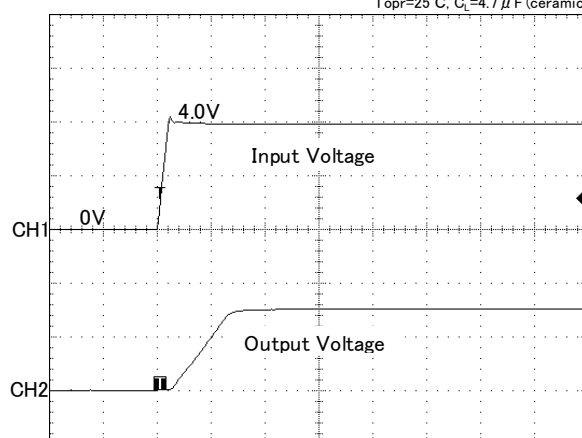
$CE=V_{IN}$ ,  $T_r=5\mu s$ ,  $I_{OUT}=0.1mA$   
 $T_{opr}=25^{\circ}C$ ,  $C_L=4.7\mu F$  (ceramic)



200  $\mu s$ /div  
 CH1: 2V/div CH2: 2V/div

#### XC6220x301

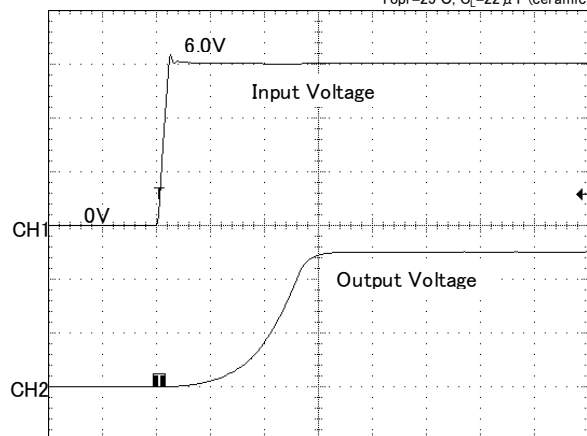
$CE=V_{IN}$ ,  $T_r=5\mu s$ ,  $I_{OUT}=300mA$   
 $T_{opr}=25^{\circ}C$ ,  $C_L=4.7\mu F$  (ceramic)



200  $\mu s$ /div  
 CH1: 2V/div CH2: 2V/div

#### XC6220x501

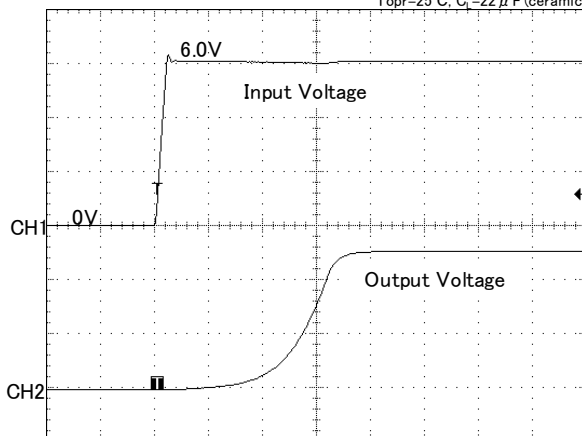
$CE=V_{IN}$ ,  $T_r=5\mu s$ ,  $I_{OUT}=0.1mA$   
 $T_{opr}=25^{\circ}C$ ,  $C_L=22\mu F$  (ceramic)



200  $\mu s$ /div  
 CH1: 2V/div CH2: 2V/div

#### XC6220x501

$CE=V_{IN}$ ,  $T_r=5\mu s$ ,  $I_{OUT}=300mA$   
 $T_{opr}=25^{\circ}C$ ,  $C_L=22\mu F$  (ceramic)

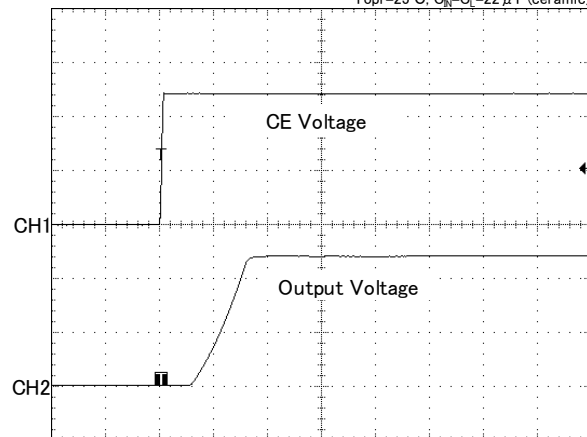


200  $\mu s$ /div  
 CH1: 2V/div CH2: 2V/div

### (12) CE Rise Characteristics

#### XC6220x121

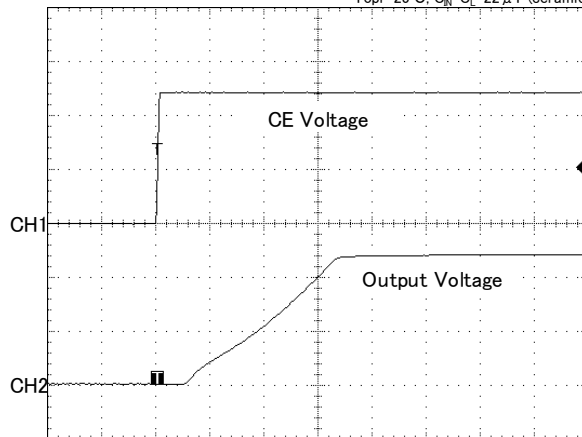
$V_{IN}=2.2V$ ,  $T_r=5\mu s$ ,  $I_{OUT}=0.1mA$   
 $T_{opr}=25^{\circ}C$ ,  $C_{IN}=C_L=22\mu F$  (ceramic)



100  $\mu s$ /div  
 CH1: 500mV/div CH2: 500mV/div

#### XC6220x121

$V_{IN}=2.2V$ ,  $T_r=5\mu s$ ,  $I_{OUT}=300mA$   
 $T_{opr}=25^{\circ}C$ ,  $C_{IN}=C_L=22\mu F$  (ceramic)



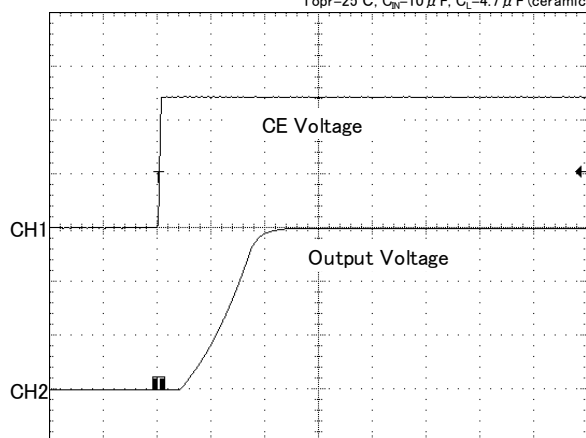
100  $\mu s$ /div  
 CH1: 500mV/div CH2: 500mV/div

## ■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (12) CE Rise Characteristics

#### XC6220x301

$V_{IN}=4.0V$ ,  $T_r=5\mu s$ ,  $I_{OUT}=0.1mA$   
 $T_{opr}=25^\circ C$ ,  $C_{IN}=10\mu F$ ,  $C_L=4.7\mu F$  (ceramic)

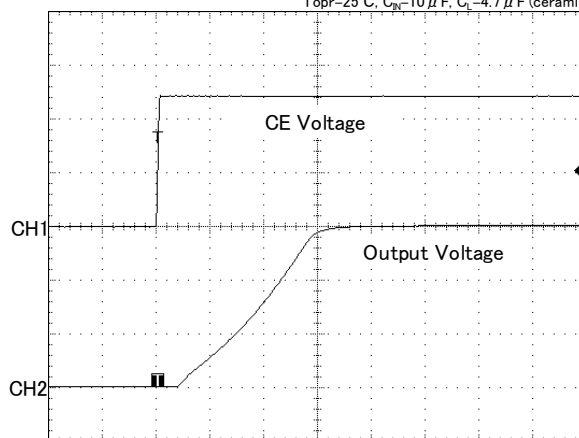


100  $\mu s$ /div

CH1 : 500mV/div CH2 : 1V/div

#### XC6220x301

$V_{IN}=4.0V$ ,  $T_r=5\mu s$ ,  $I_{OUT}=300mA$   
 $T_{opr}=25^\circ C$ ,  $C_{IN}=10\mu F$ ,  $C_L=4.7\mu F$  (ceramic)

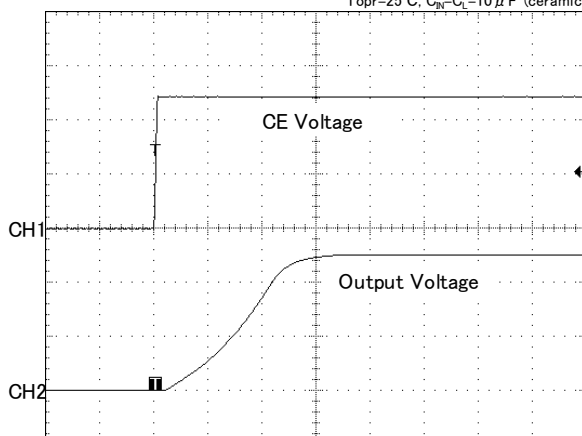


100  $\mu s$ /div

CH1 : 500mV/div CH2 : 1V/div

#### XC6220x501

$V_{IN}=6.0V$ ,  $T_r=5\mu s$ ,  $I_{OUT}=0.1mA$   
 $T_{opr}=25^\circ C$ ,  $C_{IN}=C_L=10\mu F$  (ceramic)

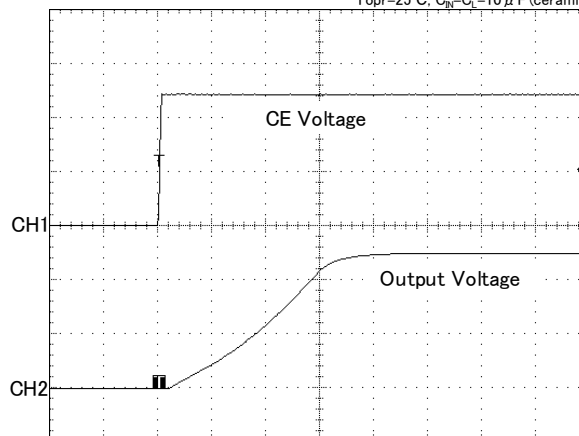


100  $\mu s$ /div

CH1 : 500mV/div CH2 : 2V/div

#### XC6220x501

$V_{IN}=6.0V$ ,  $T_r=5\mu s$ ,  $I_{OUT}=300mA$   
 $T_{opr}=25^\circ C$ ,  $C_{IN}=C_L=10\mu F$  (ceramic)



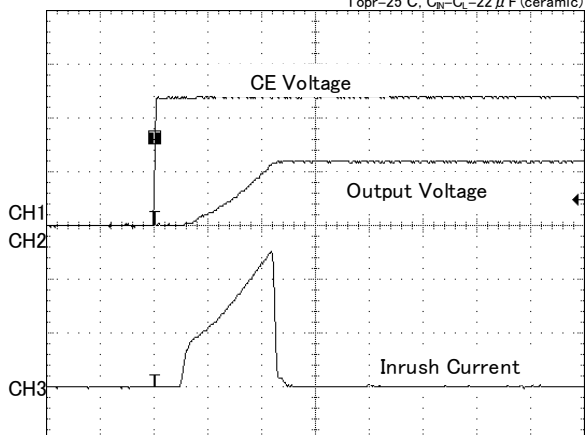
100  $\mu s$ /div

CH1 : 500mV/div CH2 : 2V/div

### (13) Inrush Current

#### XC6220x121

$V_{IN}=2.2V$ ,  $T_r=5\mu s$   
 $T_{opr}=25^\circ C$ ,  $C_{IN}=C_L=22\mu F$  (ceramic)

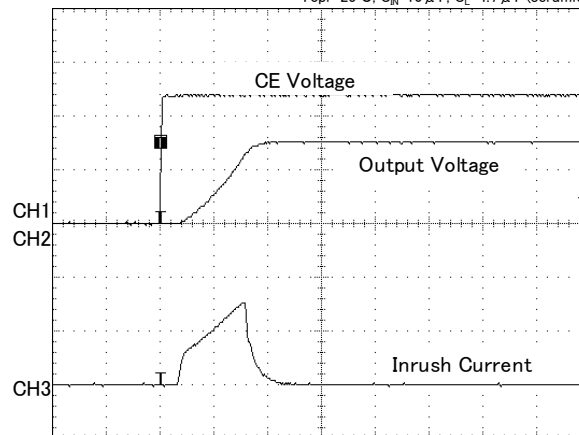


100  $\mu s$ /div

CH1 : 500mV/div CH2 : 1V/div CH3 : 100mA/div

#### XC6220x301

$V_{IN}=4.0V$ ,  $T_r=5\mu s$   
 $T_{opr}=25^\circ C$ ,  $C_{IN}=10\mu F$ ,  $C_L=4.7\mu F$  (ceramic)



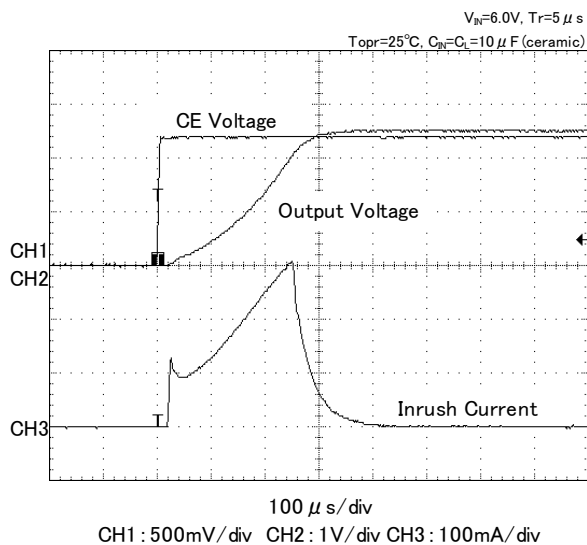
100  $\mu s$ /div

CH1 : 500mV/div CH2 : 1V/div CH3 : 100mA/div

## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

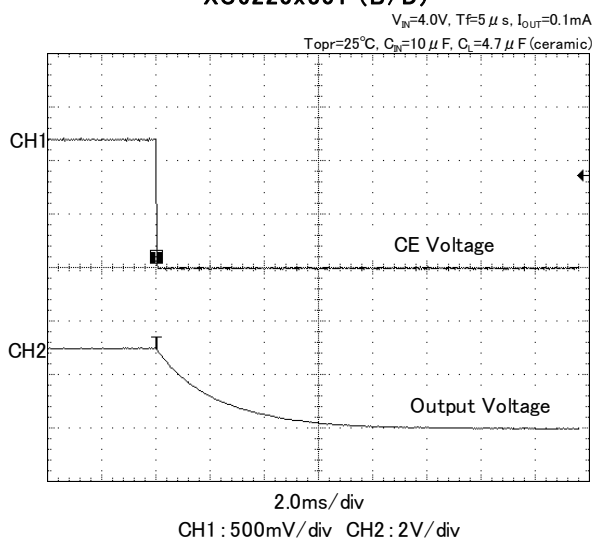
### (13) Inrush Current

#### XC6220x501

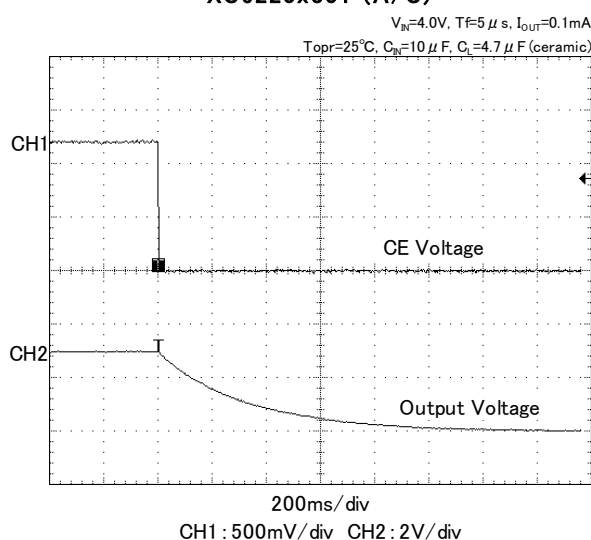


### (14) CL Discharge Time

#### XC6220x301 (B/D)

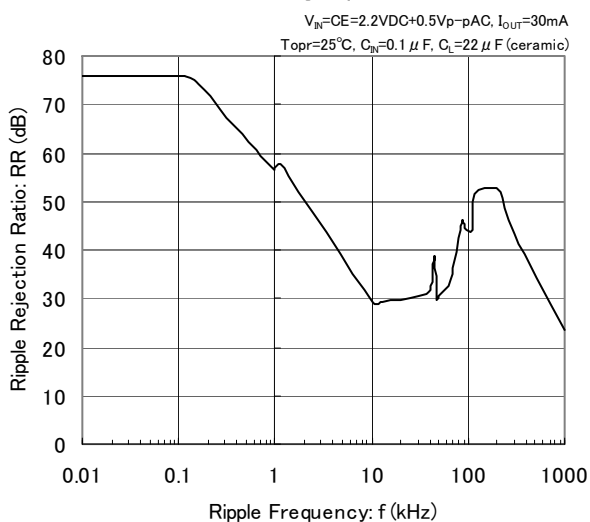


#### XC6220x301 (A/C)

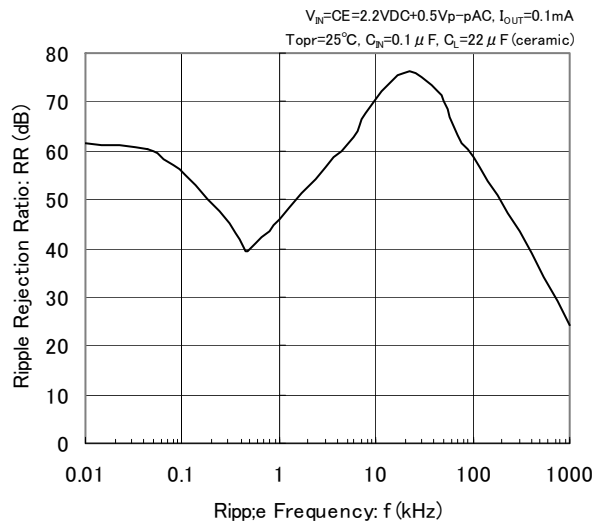


### (15) Ripple Rejection Rate

#### XC6220x121 (HighSpeed mode)

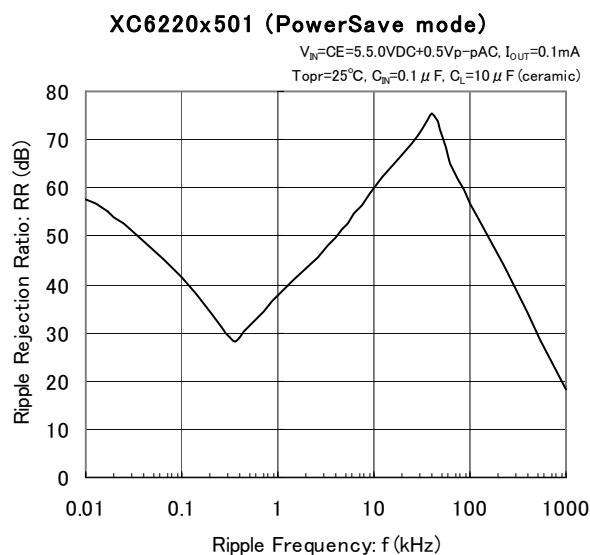
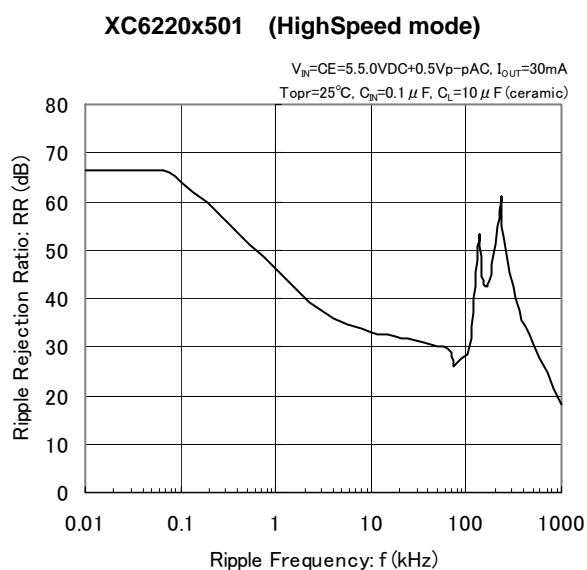
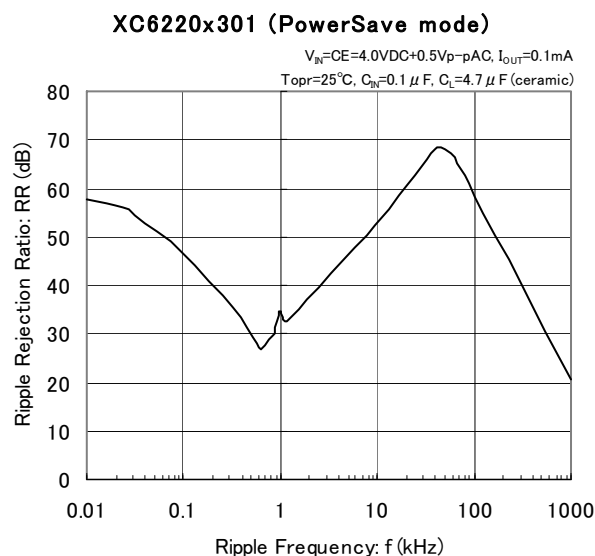
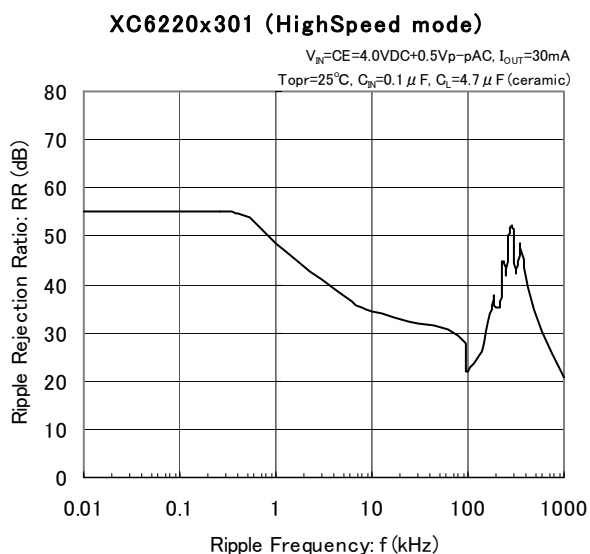


#### XC6220x121 (PowerSave mode)



## ■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

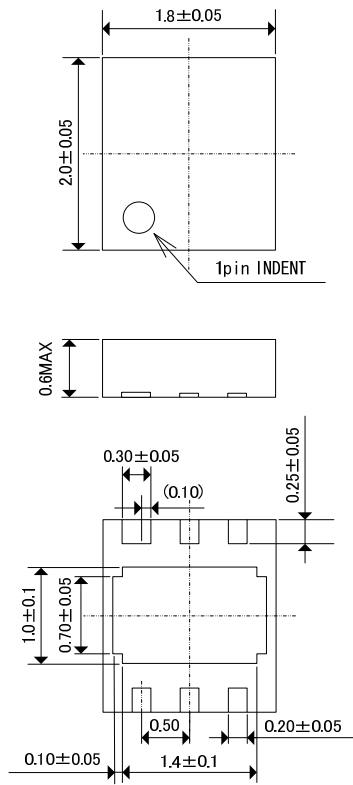
### (15) Ripple Rejection Rate



## ■ PACKAGING INFORMATION

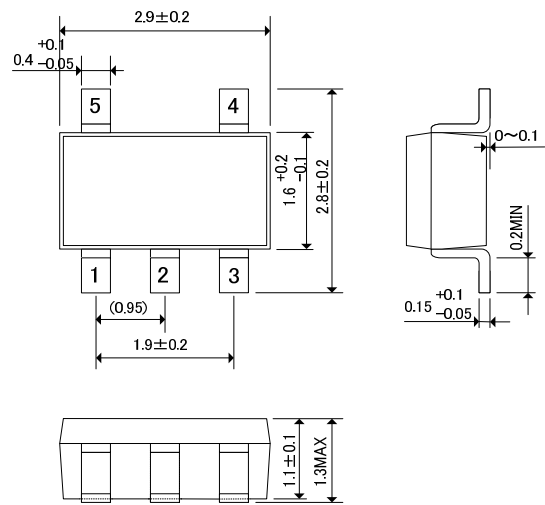
## ● USP-6C

(unit : mm)

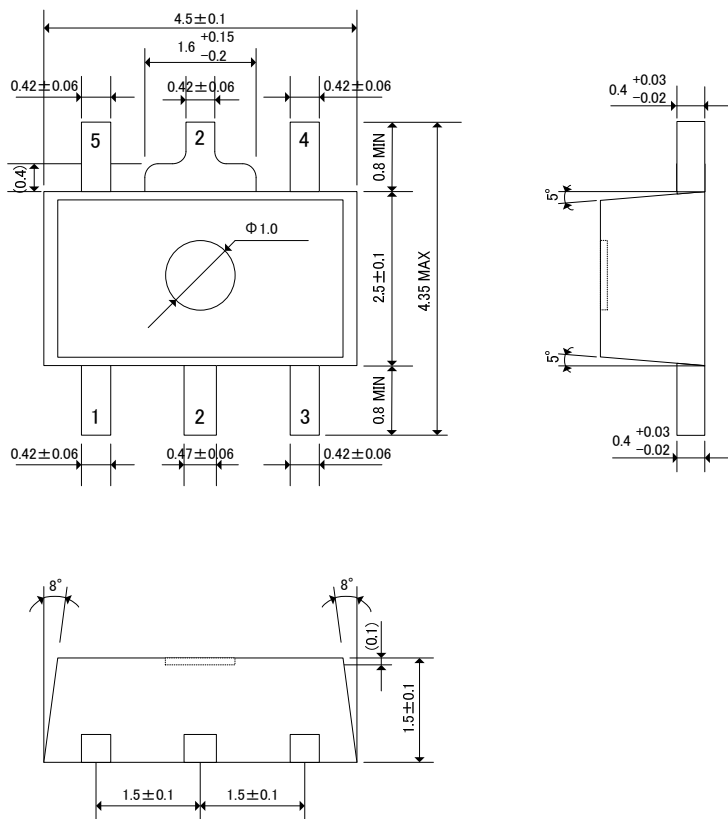


●SOT-25

(unit : mm)



## ●SOT-89-5







## ■ PACKAGING INFORMATION (Continued)

### ● SOT-25 Power Dissipation

Power dissipation data for the SOT-25 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

#### 1. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm<sup>2</sup> in one side)

Copper (Cu) traces occupy 50% of the board area

In top and back faces

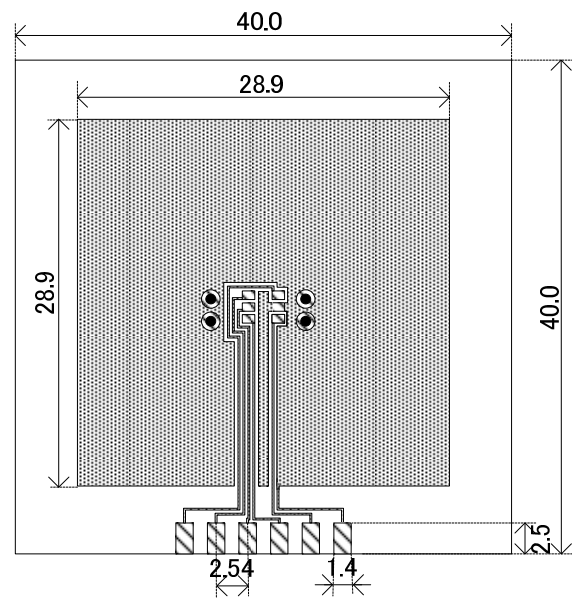
Package heat-sink is tied to the copper traces

(Board of SOT-26 is used.)

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter

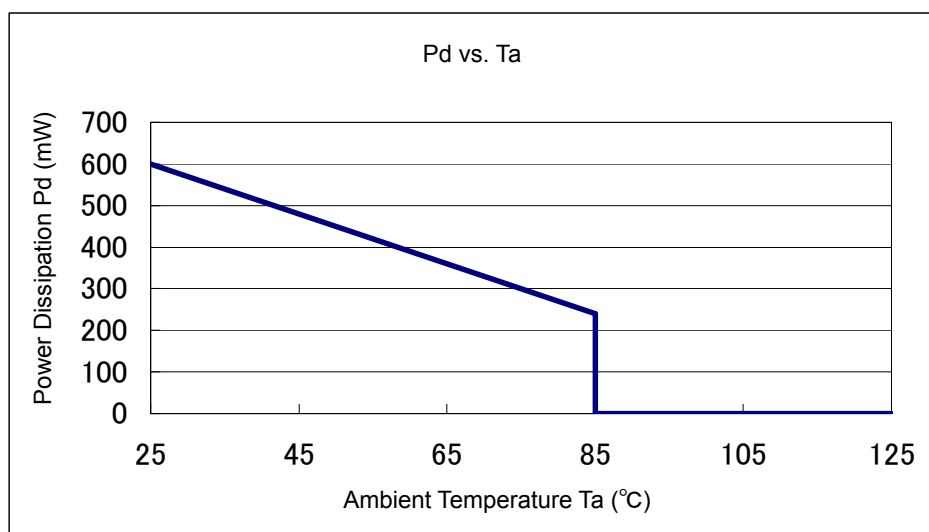


#### 2. Power Dissipation vs. Ambient temperature

Evaluation Board (Unit: mm)

Board Mount ( $T_j \text{ max} = 125^\circ\text{C}$ )

Ambient Temperature ( $^\circ\text{C}$ )	Power Dissipation $P_d$ (mW)	Thermal Resistance ( $^\circ\text{C/W}$ )
25	600	166.67
85	240	



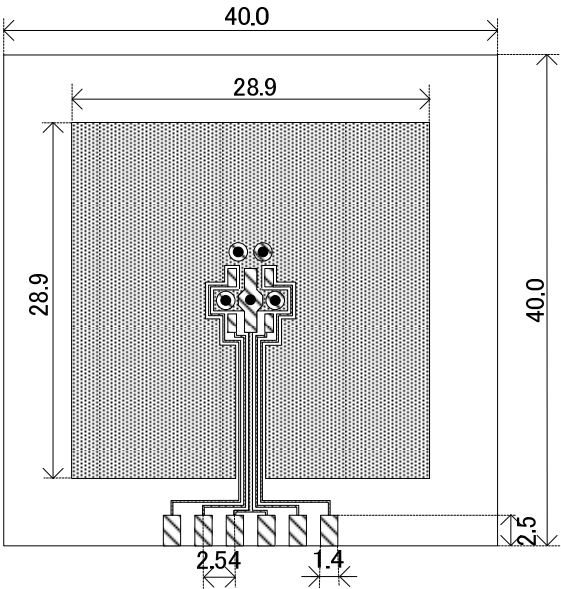
## ■ PACKAGING INFORMATION (Continued)

● SOT-89-5 Power Dissipation

Power dissipation data for the SOT-89-5 is shown in this page.  
The value of power dissipation varies with the mount board conditions.  
Please use this data as one of reference data taken in the described condition.

2. Measurement Condition (Reference data)

Condition: Mount on a board  
Ambient: Natural convection  
Soldering: Lead (Pb) free  
Board: Dimensions 40 x 40 mm (1600 mm<sup>2</sup> in one side)  
Copper (Cu) traces occupy 50% of the board area  
In top and back faces  
Package heat-sink is tied to the copper traces  
Material: Glass Epoxy (FR-4)  
Thickness: 1.6 mm  
Through-hole: 5 x 0.8 Diameter

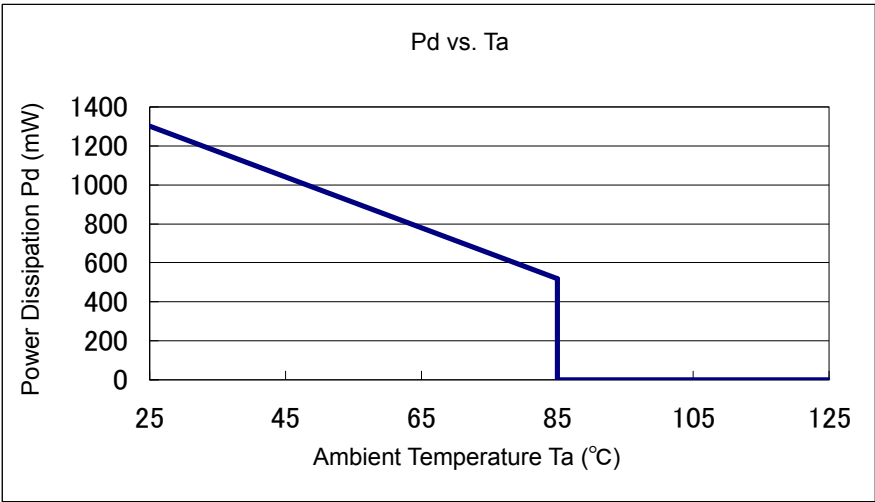


2. Power Dissipation vs. Ambient temperature

Evaluation Board (Unit: mm)

Board Mount ( $T_j \text{ max} = 125^\circ\text{C}$ )

Ambient Temperature ( $^\circ\text{C}$ )	Power Dissipation $P_d$ (mW)	Thermal Resistance ( $^\circ\text{C/W}$ )
25	1300	76.92
85	520	



## PACKAGING INFORMATION (Continued)

### ● USP-6C Power Dissipation

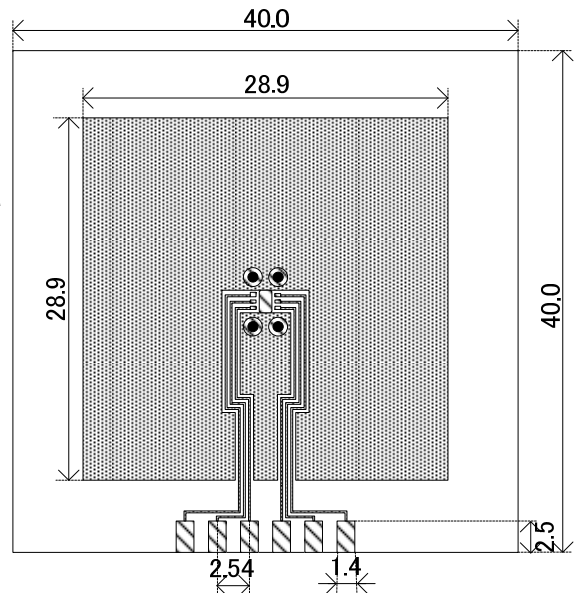
Power dissipation data for the USP-6C is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

#### 3. Measurement Condition (Reference data)

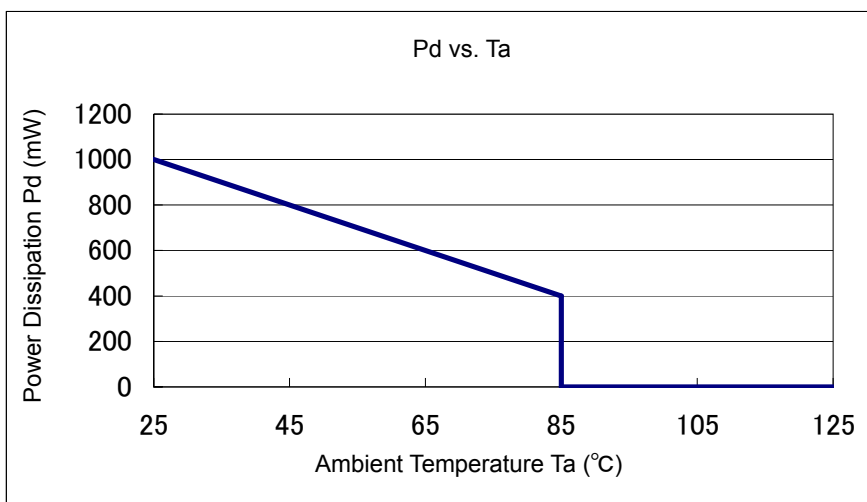
Condition: Mount on a board  
 Ambient: Natural convection  
 Soldering: Lead (Pb) free  
 Board: Dimensions 40 x 40 mm (1600 mm<sup>2</sup> in one side)  
         Copper (Cu) traces occupy 50% of the board area  
         In top and back faces  
         Package heat-sink is tied to the copper traces  
 Material: Glass Epoxy (FR-4)  
 Thickness: 1.6 mm  
 Through-hole: 4 x 0.8 Diameter



Evaluation Board (Unit: mm)

Board Mount ( $T_j \text{ max} = 125^\circ\text{C}$ )

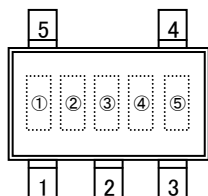
Ambient Temperature ( $^\circ\text{C}$ )	Power Dissipation Pd (mW)	Thermal Resistance ( $^\circ\text{C}/\text{W}$ )
25	1000	100.00
85	400	



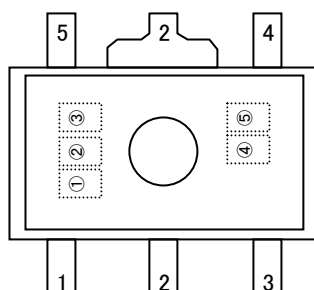
## MARKING RULE

### ● SOT-25, SOT-89-5

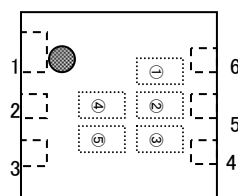
SOT25



SOT89-5



USP6C



① represents product series

MARK	PRODUCT SERIES
H	XC6220*****

② represents type of CE, voltage range, and accuracy

MARK	CE	OUTPUT VOLTAGE RANGE	OUTPUT VOLTAGE ACCURACY	PRODUCT SERIES
0	A	0.8~2.9	1	XC6220A081** ~ XC6220A291**
1	A	0.8~2.9	B	XC6220A08B** ~ XC6220A29B**
2	A	3.0~5.0	1	XC6220A301** ~ XC6220A501**
3	A	3.0~4.9	B	XC6220A30B** ~ XC6220A49B**
4	B	0.8~2.9	1	XC6220B081** ~ XC6220B291**
5	B	0.8~2.9	B	XC6220B08B** ~ XC6220B29B**
6	B	3.0~5.0	1	XC6220B301** ~ XC6220B501**
7	B	3.0~4.9	B	XC6220B30B** ~ XC6220B49B**
8	C	0.8~2.9	1	XC6220C081** ~ XC6220C291**
9	C	0.8~2.9	B	XC6220C08B** ~ XC6220C29B**
A	C	3.0~5.0	1	XC6220C301** ~ XC6220C501**
B	C	3.0~4.9	B	XC6220C30B** ~ XC6220C49B**
C	D	0.8~2.9	1	XC6220D081** ~ XC6220D291**
D	D	0.8~2.9	B	XC6220D08B** ~ XC6220D29B**
E	D	3.0~5.0	1	XC6220D301** ~ XC6220D501**
F	D	3.0~4.9	B	XC6220D30B** ~ XC6220D49B**

\* Accuracy "1"...0.1V increments, Accuracy "B"...0.05V increments

③ represents output voltage

MARK	OUTPUT VOLTAGE (V)		MARK	OUTPUT VOLTAGE (V)		MARK	OUTPUT VOLTAGE (V)	
0	—	3.0x	A	1.0x	4.0x	N	2.0x	5.0x
1	—	3.1x	B	1.1x	4.1x	P	2.1x	—
2	—	3.2x	C	1.2x	4.2x	R	2.2x	—
3	—	3.3x	D	1.3x	4.3x	S	2.3x	—
4	—	3.4x	E	1.4x	4.4x	T	2.4x	—
5	—	3.5x	F	1.5x	4.5x	U	2.5x	—
6	—	3.6x	H	1.6x	4.6x	V	2.6x	—
7	—	3.7x	K	1.7x	4.7x	X	2.7x	—
8	0.8x	3.8x	L	1.8x	4.8x	Y	2.8x	—
9	0.9x	3.9x	M	1.9x	4.9x	Z	2.9x	—

④,⑤ represents production lot number  
01~09、0A~0Z、11~9Z、A1~A9、AA~Z9、ZA~ZZ repeated  
(G, I, J, O, Q, W excluded)  
\*No character inversion used.

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